## Am29LV065D

Data Sheet



July 2003

The following document specifies Spansion memory products that are now offered by both Advanced Micro Devices and Fujitsu. Although the document is marked with the name of the company that originally developed the specification, these products will be offered to customers of both AMD and Fujitsu.

## **Continuity of Specifications**

There is no change to this datasheet as a result of offering the device as a Spansion product. Any changes that have been made are the result of normal datasheet improvement and are noted in the document revision summary, where supported. Future routine revisions will occur when appropriate, and changes will be noted in a revision summary.

## **Continuity of Ordering Part Numbers**

AMD and Fujitsu continue to support existing part numbers beginning with "Am" and "MBM". To order these products, please use only the Ordering Part Numbers listed in this document.

#### For More Information

Please contact your local AMD or Fujitsu sales office for additional information about Spansion memory solutions.







## Am29LV065D

# 64 Megabit (8 M x 8-Bit) CMOS 3.0 Volt-only Uniform Sector Flash Memory with VersatilelO™ Control

#### DISTINCTIVE CHARACTERISTICS

#### ■ Single power supply operation

— 3.0 to 3.6 volt read, erase, and program operations

#### ■ VersatileIO<sup>™</sup> control

 Device generates output voltages and tolerates input voltages on the DQ I/Os as determined by the voltage on V<sub>IO</sub> input

#### **■** High performance

- Access times as fast as 90 ns

#### ■ Manufactured on 0.23 µm process technology

#### ■ CFI (Common Flash Interface) compliant

 Provides device-specific information to the system, allowing host software to easily reconfigure for different Flash devices

#### ■ SecSi (Secured Silicon) Sector region

- 256-byte sector for permanent, secure identification through an 16-byte random Electronic Serial Number
- May be programmed and locked at the factory or by the customer
- Accessible through a command sequence

#### Ultra low power consumption (typical values at 3.0 V, 5 MHz)

- 9 mA typical active read current
- 26 mA typical erase/program current
- 200 nA typical standby mode current

#### **■** Flexible sector architecture

One hundred twenty-eight 64 Kbyte sectors

#### ■ Sector Protection

- A hardware method to lock a sector to prevent program or erase operations within that sector
- Sectors can be locked in-system or via programming equipment
- Temporary Sector Unprotect feature allows code changes in previously locked sectors

#### ■ Embedded Algorithms

- Embedded Erase algorithm automatically preprograms and erases the entire chip or any combination of designated sectors
- Embedded Program algorithm automatically writes and verifies data at specified addresses

## ■ Compatibility with JEDEC standards

- Pinout and software compatible with single-power supply Flash
- Superior inadvertent write protection

#### ■ Minimum 1 million erase cycle guarantee per sector

#### ■ Package options

- 48-pin TSOP (standard or reverse pinout)
- 63-ball FBGA

#### ■ Erase Suspend/Erase Resume

 Suspends an erase operation to read data from, or program data to, a sector that is not being erased, then resumes the erase operation

#### ■ Data# Polling and toggle bits

 Provides a software method of detecting program or erase operation completion

#### ■ Unlock Bypass Program command

 Reduces overall programming time when issuing multiple program command sequences

#### ■ Ready/Busy# pin (RY/BY#)

 Provides a hardware method of detecting program or erase cycle completion

#### ■ Hardware reset pin (RESET#)

Hardware method to reset the device for reading array data

#### ■ ACC pin

 Accelerates programming time for higher throughput during system production

#### Program and Erase Performance (V<sub>HH</sub> not applied to the ACC input pin)

- Byte program time: 5 µs typical
- Sector erase time: 0.9 s typical for each 64 Kbyte sector

#### 20-year data retention at 125°C

Reliable operation for the life of the system

Publication# 23544 Rev: B Amendment/0 Issue Date: January 10, 2002



#### **GENERAL DESCRIPTION**

The Am29LV065D is a 64 Mbit, 3.0 Volt (3.0 V to 3.6 V) single power supply flash memory devices organized as 8,388,608 bytes. Data appears on DQ0-DQ7. The device is designed to be programmed in-system with the standard system 3.0 volt  $V_{\rm CC}$  supply. A 12.0 volt  $V_{\rm PP}$  is not required for program or erase operations. The device can also be programmed in standard EPROM programmers.

The device offers access times of 90, 100, and 120 ns. The device is offered in standard or reverse 48-pin TSOP and 63-ball FBGA packages. To eliminate bus contention each device has separate chip enable (CE#), write enable (WE#) and output enable (OE#) controls.

Each device requires only a **single 3.0 Volt power supply** (3.0 V to 3.6 V) for both read and write functions. Internally generated and regulated voltages are provided for the program and erase operations.

The device is entirely command set compatible with the JEDEC single-power-supply Flash standard. Commands are written to the command register using standard microprocessor write timing. Register contents serve as inputs to an internal state-machine that controls the erase and programming circuitry. Write cycles also internally latch addresses and data needed for the programming and erase operations. Reading data out of the device is similar to reading from other Flash or EPROM devices.

Device programming occurs by executing the program command sequence. This initiates the **Embedded Program** algorithm—an internal algorithm that automatically times the program pulse widths and verifies proper cell margin. The Unlock Bypass mode facilitates faster programming times by requiring only two write cycles to program data instead of four.

Device erasure occurs by executing the erase command sequence. This initiates the **Embedded Erase** algorithm—an internal algorithm that automatically preprograms the array (if it is not already programmed) before executing the erase operation. During erase, the device automatically times the erase pulse widths and verifies proper cell margin.

The **VersatileIO**<sup>TM</sup> ( $V_{IO}$ ) control allows the host system to set the voltage levels that the device generates and tolerates on CE# and DQ I/Os to the same voltage level that is asserted on  $V_{IO}$ .  $V_{IO}$  is available in two configurations (1.8–2.9 V and 3.0–5.0 V) for operation in various system environments.

The host system can detect whether a program or erase operation is complete by observing the RY/BY#

pin, by reading the DQ7 (Data# Polling), or DQ6 (toggle) **status bits**. After a program or erase cycle has been completed, the device is ready to read array data or accept another command.

The **sector erase architecture** allows memory sectors to be erased and reprogrammed without affecting the data contents of other sectors. The device is fully erased when shipped from the factory.

Hardware data protection measures include a low  $V_{\rm CC}$  detector that automatically inhibits write operations during power transitions. The hardware sector protection feature disables both program and erase operations in any combination of sectors of memory. This can be achieved in-system or via programming equipment.

The **Erase Suspend/Erase Resume** feature enables the user to put erase on hold for any period of time to read data from, or program data to, any sector that is not selected for erasure. True background erase can thus be achieved.

The hardware RESET# pin terminates any operation in progress and resets the internal state machine to reading array data. The RESET# pin may be tied to the system reset circuitry. A system reset would thus also reset the device, enabling the system microprocessor to read boot-up firmware from the Flash memory device.

The device offers a **standby mode** as a power-saving feature. Once the system places the device into the standby mode power consumption is greatly reduced.

The SecSi<sup>™</sup> (Secured Silicon) Sector provides an minimum 256-byte area for code or data that can be permanently protected. Once this sector is protected, no further programming or erasing within the sector can occur.

The **accelerated program (ACC)** feature allows the system to program the device at a much faster rate. When ACC is pulled high to V<sub>HH</sub>, the device enters the Unlock Bypass mode, enabling the user to reduce the time needed to do the program operation. This feature is intended to increase factory throughput during system production, but may also be used in the field if desired.

AMD's Flash technology combines years of Flash memory manufacturing experience to produce the highest levels of quality, reliability and cost effectiveness. The device electrically erases all bits within a sector simultaneously via Fowler-Nordheim tunnelling. The data is programmed using hot electron injection.



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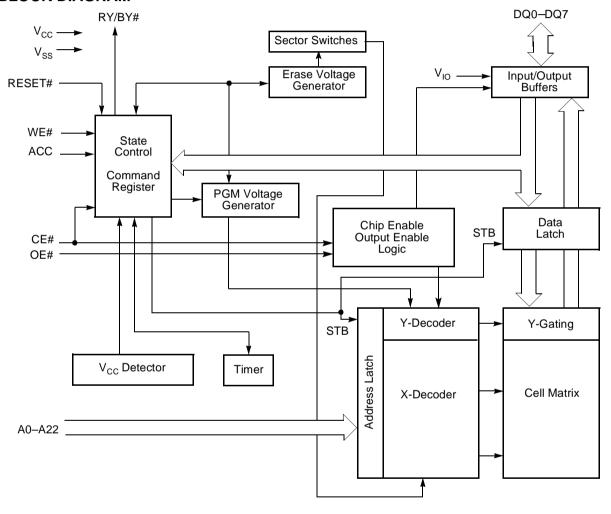


## **PRODUCT SELECTOR GUIDE**

Part Number		Am29LV065D					
Speed Option	$V_{CC} = 3.0-3.6 \text{ V}, V_{IO} = 3.0-5.0 \text{ V}$	90R		120R			
Speed Option	$V_{CC} = 3.0-3.6 \text{ V}, V_{IO} = 1.8-2.9 \text{ V}$		101R	121R			
Max Access Time	(ns)	90	100	120			
CE# Access Time	(ns)	90	100	120			
OE# Access Time	(ns)	35	35	50			

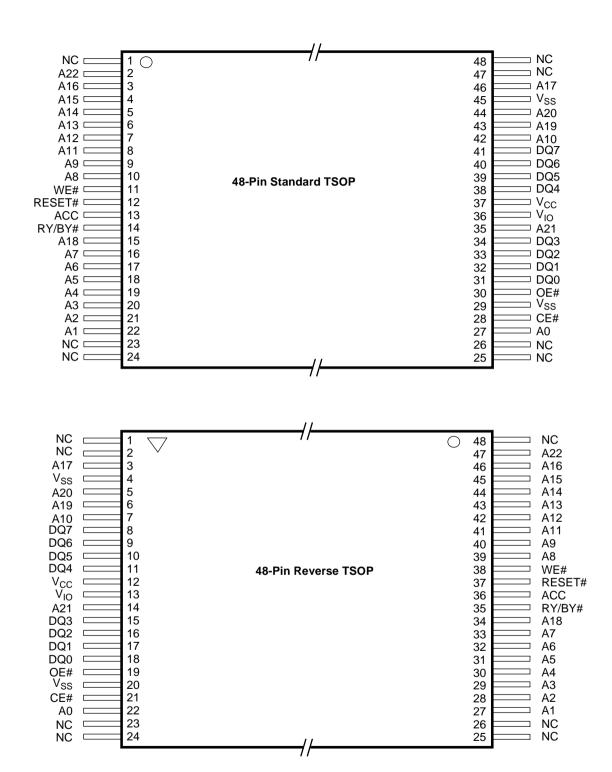
Note: See "AC Characteristics" for full specifications.

## **BLOCK DIAGRAM**





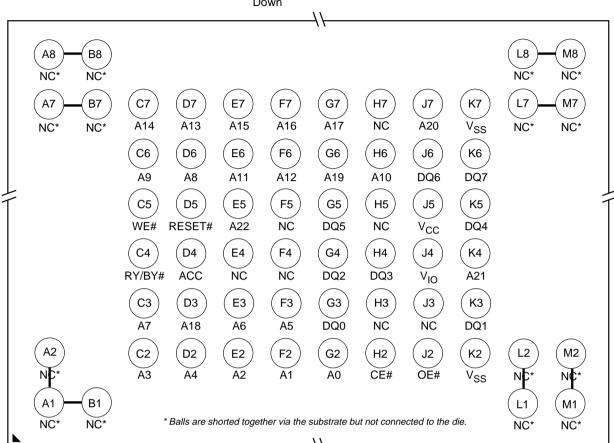
## **CONNECTION DIAGRAMS**





#### **CONNECTION DIAGRAMS**

# **63-Ball FBGA**Top View, Balls Facing Down



# **Special Handling Instructions for FBGA Package**

Special handling is required for Flash Memory products in FBGA packages.

Flash memory devices in FBGA packages may be damaged if exposed to ultrasonic cleaning methods. The package and/or data integrity may be compromised if the package body is exposed to temperatures above 150°C for prolonged periods of time.



### **PIN DESCRIPTION**

A0-A22 = 23 Addresses inputs
DQ0-DQ7 = 8 Data inputs/outputs
CE# = Chip Enable input

OE# = Output Enable input
WE# = Write Enable input
ACC = Acceleration Input

RESET# = Hardware Reset Pin input

RY/BY# = Ready/Busy output

 $V_{CC}$  = 3.0 volt-only single power supply

(see Product Selector Guide for speed options and voltage

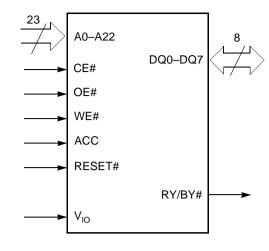
supply tolerances)

 $V_{IO}$  = Output Buffer power

 $V_{SS}$  = Device Ground

NC = Pin Not Connected Internally

### LOGIC SYMBOL

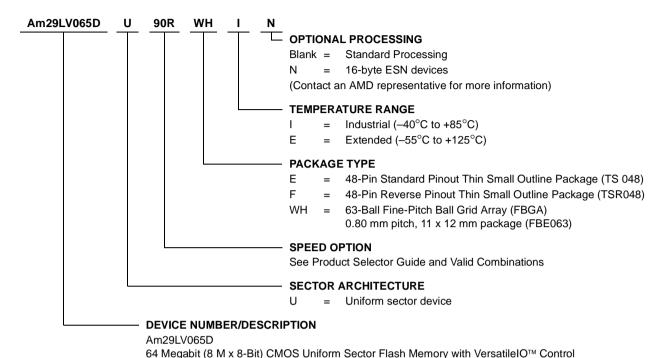




#### ORDERING INFORMATION

#### Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the following:



**Valid Combinations for TSOP Packages** Speed/V<sub>IO</sub> Range AM29LV065DU90R, 90ns. AM29LV065DU90R  $V_{10} = 3.0 \text{ V} - 5.0 \text{ V}$ EI, FI AM29LV065DU101R. 100 ns. AM29LV065DU101R  $V_{10} = 1.8 \text{ V} - 2.9 \text{ V}$ AM29LV065DU120R, 120 ns, AM29LV065DU120R  $V_{10} = 3.0 \text{ V} - 5.0 \text{ V}$ EI, EE, FI, FE 120 ns,

AM29LV065DU121R, AM29LV065DU121R 3.0 Volt-only Read, Program, and Erase

 $V_{10} = 1.8 \text{ V} - 2.9 \text{ V}$ 

Valid Combinations				
Order Number		Package Marking		Speed/ V <sub>IO</sub> Range
AM29LV065DU90R	WHI	L065DU90R	1	$90 \text{ ns}, V_{IO} = 3.0 \text{ V} - 5.0 \text{ V}$
AM29LV065DU101R	VVIII	L065DU01R	ı	100 ns, V <sub>IO</sub> = 1.8 V - 2.9 V
AM29LV065DU120R	WHI,	L065DU12R	I,	$120 \text{ ns}, V_{IO} = 3.0 \text{ V} - 5.0 \text{ V}$
AM29LV065DU121R	WHE	L065DU21R		120 ns, V <sub>IO</sub> = 1.8 V – 2.9 V

#### **Valid Combinations**

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.



#### **DEVICE BUS OPERATIONS**

This section describes the requirements and use of the device bus operations, which are initiated through the internal command register. The command register itself does not occupy any addressable memory location. The register is a latch used to store the commands, along with the address and data information needed to execute the command. The contents of the register serve as inputs to the internal state machine. The state machine outputs dictate the function of the device. Table 1 lists the device bus operations, the inputs and control levels they require, and the resulting output. The following subsections describe each of these operations in further detail.

Operation	CE#	OE#	WE#	RESET#	ACC	Addresses (Note 2)	DQ0- DQ7
Read	L	L	Н	Н	Х	A <sub>IN</sub>	D <sub>OUT</sub>
Write (Program/Erase)	L	Н	L	Н	Х	A <sub>IN</sub>	(Note 4)
Accelerated Program	L	Н	L	Н	V <sub>HH</sub>	A <sub>IN</sub>	(Note 4)
Standby	V <sub>CC</sub> ± 0.3 V	Х	х	V <sub>CC</sub> ± 0.3 V	Н	Х	High-Z
Output Disable	L	Н	Н	Н	Х	Х	High-Z
Reset	Х	Х	Х	L	Х	Х	High-Z
Sector Group Protect (Note 2)	L	Н	L	V <sub>ID</sub>	Х	SA, A6 = L, A1 = H, A0 = L	(Note 4)
Sector Group Unprotect (Note 2)	L	Н	L	V <sub>ID</sub>	Х	SA, A6 = H, A1 = H, A0 = L	(Note 4)
Temporary Sector Group Unprotect	Х	Х	Х	V <sub>ID</sub>	Х	A <sub>IN</sub>	(Note 4)

Table 1. Am29LV065D Device Bus Operations

**Legend:**  $L = Logic \ Low = V_{IL}$ ,  $H = Logic \ High = V_{IH}$ ,  $V_{ID} = 8.5 - 12.5 \ V$ ,  $V_{HH} = 11.5 - 12.5 \ V$ ,  $X = Don't \ Care$ ,  $SA = Sector \ Address$ ,  $A_{IN} = Address \ In$ ,  $D_{IN} = Data \ In$ ,  $D_{OUT} = Data \ Out$ 

#### Notes:

- 1. Addresses are A22:A0. Sector addresses are A22:A16.
- 2. The sector protect and sector unprotect functions may also be implemented via programming equipment. See the "Sector Group Protection and Unprotection" section.
- 3. All sectors are unprotected when shipped from the factory (The SecSi Sector may be factory protected depending on version ordered.)
- 4.  $D_{IN}$  or  $D_{OUT}$  as required by command sequence, data polling, or sector protect algorithm (see Figure 2).

## VersatilelO™ (V<sub>IO</sub>) Control

The VersatileIO<sup>TM</sup> (V<sub>IO</sub>) control allows the host system to set the voltage levels that the device generates and tolerates on CE# and DQ I/Os to the same voltage level that is asserted on V<sub>IO</sub>. V<sub>IO</sub> is available in two configurations (1.8–2.9 V and 3.0–5.0 V) for operation in various system environments.

For example, a  $V_{I/O}$  of 4.5–5.0 volts allows for I/O at the 5 volt level, driving and receiving signals to and from other 5 V devices on the same data bus.

## Requirements for Reading Array Data

To read array data from the outputs, the system must drive the CE# and OE# pins to  $V_{\rm IL}$ . CE# is the power control and selects the device. OE# is the output control and gates array data to the output pins. WE# should remain at  $V_{\rm IH}$ .

The internal state machine is set for reading array data upon device power-up, or after a hardware reset. This ensures that no spurious alteration of the memory content occurs during the power transition. No command is necessary in this mode to obtain array data. Standard microprocessor read cycles that assert valid addresses on the device address inputs produce valid data on the device data outputs. The device remains



enabled for read access until the command register contents are altered.

See "VersatileIO<sup>TM</sup> ( $V_{IO}$ ) Control" for more information. Refer to the AC Read-Only Operations table for timing specifications and to Figure 13 for the timing diagram.  $I_{CC1}$  in the DC Characteristics table represents the active current specification for reading array data.

### **Writing Commands/Command Sequences**

To write a command or command sequence (which includes programming data to the device and erasing sectors of memory), the system must drive WE# and CE# to  $V_{II}$ , and OE# to  $V_{IH}$ .

The device features an **Unlock Bypass** mode to facilitate faster programming. Once the device enters the Unlock Bypass mode, only two write cycles are required to program a byte, instead of four. The "Byte Program Command Sequence" section has details on programming data to the device using both standard and Unlock Bypass command sequences.

An erase operation can erase one sector, multiple sectors, or the entire device. Table 2 indicates the address space that each sector occupies.

 $I_{\text{CC2}}$  in the DC Characteristics table represents the active current specification for the write mode. The AC Characteristics section contains timing specification tables and timing diagrams for write operations.

### **Accelerated Program Operation**

The device offers accelerated program operations through the ACC function. This function is primarily intended to allow faster manufacturing throughput during system production.

If the system asserts  $V_{HH}$  on this pin, the device automatically enters the aforementioned Unlock Bypass mode, temporarily unprotects any protected sectors, and uses the higher voltage on the pin to reduce the time required for program operations. The system would use a two-cycle program command sequence as required by the Unlock Bypass mode. Removing  $V_{HH}$  from the ACC pin returns the device to normal operation. Note that the ACC pin must not be at  $V_{HH}$  for operations other than accelerated programming, or device damage may result.

#### **Autoselect Functions**

If the system writes the autoselect command sequence, the device enters the autoselect mode. The system can then read autoselect codes from the internal register (which is separate from the memory array) on DQ7–DQ0. Standard read cycle timings apply in this mode. Refer to the Autoselect Mode and Autoselect Command Sequence sections for more information.

## **Standby Mode**

When the system is not reading or writing to the device, it can place the device in the standby mode. In this mode, current consumption is greatly reduced, and the outputs are placed in the high impedance state, independent of the OE# input.

The device enters the CMOS standby mode when the CE# and RESET# pins are both held at  $V_{CC} \pm 0.3 \text{ V}$ . (Note that this is a more restricted voltage range than  $V_{IH}$ .) If CE# and RESET# are held at  $V_{IH}$ , but not within  $V_{CC} \pm 0.3 \text{ V}$ , the device will be in the standby mode, but the standby current will be greater. The device requires standard access time ( $t_{CE}$ ) for read access when the device is in either of these standby modes, before it is ready to read data.

If the device is deselected during erasure or programming, the device draws active current until the operation is completed.

 $\ensuremath{I_{\text{CC3}}}$  in the DC Characteristics table represents the standby current specification.

## **Automatic Sleep Mode**

The automatic sleep mode minimizes Flash device energy consumption. The device automatically enables this mode when addresses remain stable for  $t_{\rm ACC}$  + 30 ns. The automatic sleep mode is independent of the CE#, WE#, and OE# control signals. Standard address access timings provide new data when addresses are changed. While in sleep mode, output data is latched and always available to the system.  $l_{\rm CC4}$  in the DC Characteristics table represents the automatic sleep mode current specification.

#### **RESET#: Hardware Reset Pin**

The RESET# pin provides a hardware method of resetting the device to reading array data. When the RESET# pin is driven low for at least a period of t<sub>RP</sub>, the device immediately terminates any operation in progress, tristates all output pins, and ignores all read/write commands for the duration of the RESET# pulse. The device also resets the internal state machine to reading array data. The operation that was interrupted should be reinitiated once the device is ready to accept another command sequence, to ensure data integrity.

Current is reduced for the duration of the RESET# pulse. When RESET# is held at  $V_{SS}\pm0.3$  V, the device draws CMOS standby current ( $I_{CC4}$ ). If RESET# is held at  $V_{IL}$  but not within  $V_{SS}\pm0.3$  V, the standby current will be greater.

The RESET# pin may be tied to the system reset circuitry. A system reset would thus also reset the Flash memory, enabling the system to read the boot-up firmware from the Flash memory.



If RESET# is asserted during a program or erase operation, the RY/BY# pin remains a "0" (busy) until the internal reset operation is complete, which requires a time of  $t_{READY}$  (during Embedded Algorithms). The system can thus monitor RY/BY# to determine whether the reset operation is complete. If RESET# is asserted when a program or erase operation is not executing (RY/BY# pin is "1"), the reset operation is completed within a time of  $t_{READY}$  (not during Embedded

Algorithms). The system can read data  $t_{\text{RH}}$  after the RESET# pin returns to  $V_{\text{IH}}.$ 

Refer to the AC Characteristics tables for RESET# parameters and to Figure 14 for the timing diagram.

## **Output Disable Mode**

When the OE# input is at  $V_{IH}$ , output from the device is disabled. The output pins are placed in the high impedance state.

Table 2. Sector Address Table

Sector	A22	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA0	0	0	0	0	0	0	0	000000-00FFFF
SA1	0	0	0	0	0	0	1	010000-01FFFF
SA2	0	0	0	0	0	1	0	020000-02FFFF
SA3	0	0	0	0	0	1	1	030000-03FFFF
SA4	0	0	0	0	1	0	0	040000-04FFFF
SA5	0	0	0	0	1	0	1	050000-05FFFF
SA6	0	0	0	0	1	1	0	060000-06FFFF
SA7	0	0	0	0	1	1	1	070000-07FFFF
SA8	0	0	0	1	0	0	0	080000-08FFFF
SA9	0	0	0	1	0	0	1	090000-09FFFF
SA10	0	0	0	1	0	1	0	0A0000-0AFFFF
SA11	0	0	0	1	0	1	1	0B0000-0BFFFF
SA12	0	0	0	1	1	0	0	0C0000-0CFFFF
SA13	0	0	0	1	1	0	1	0D0000-0DFFFF
SA14	0	0	0	1	1	1	0	0E0000-0EFFFF
SA15	0	0	0	1	1	1	1	0F0000-0FFFFF
SA16	0	0	1	0	0	0	0	100000-10FFFF
SA17	0	0	1	0	0	0	1	110000-11FFFF
SA18	0	0	1	0	0	1	0	120000-12FFFF
SA19	0	0	1	0	0	1	1	130000-13FFFF
SA20	0	0	1	0	1	0	0	140000-14FFFF
SA21	0	0	1	0	1	0	1	150000-15FFFF
SA22	0	0	1	0	1	1	0	160000-16FFFF
SA23	0	0	1	0	1	1	1	170000-17FFFF
SA24	0	0	1	1	0	0	0	180000–18FFFF
SA25	0	0	1	1	0	0	1	190000-19FFFF
SA26	0	0	1	1	0	1	0	1A0000-1AFFFF



Table 2. Sector Address Table (Continued)

Sector	A22	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA27	0	0	1	1	0	1	1	1B0000-1BFFFF
SA28	0	0	1	1	1	0	0	1C0000-1CFFFF
SA29	0	0	1	1	1	0	1	1D0000-1DFFFF
SA30	0	0	1	1	1	1	0	1E0000-1EFFFF
SA31	0	0	1	1	1	1	1	1F0000-1FFFFF
SA32	0	1	0	0	0	0	0	200000-20FFFF
SA33	0	1	0	0	0	0	1	210000-21FFFF
SA34	0	1	0	0	0	1	0	220000-22FFFF
SA35	0	1	0	0	0	1	1	230000-23FFFF
SA36	0	1	0	0	1	0	0	240000-24FFFF
SA37	0	1	0	0	1	0	1	250000-25FFFF
SA38	0	1	0	0	1	1	0	260000-26FFFF
SA39	0	1	0	0	1	1	1	270000–27FFFF
SA40	0	1	0	1	0	0	0	280000-28FFFF
SA41	0	1	0	1	0	0	1	290000-29FFFF
SA42	0	1	0	1	0	1	0	2A0000–2AFFFF
SA43	0	1	0	1	0	1	1	2B0000-2BFFFF
SA44	0	1	0	1	1	0	0	2C0000-2CFFFF
SA45	0	1	0	1	1	0	1	2D0000–2DFFFF
SA46	0	1	0	1	1	1	0	2E0000-2EFFFF
SA47	0	1	0	1	1	1	1	2F0000–2FFFFF
SA48	0	1	1	0	0	0	0	300000-30FFFF
SA49	0	1	1	0	0	0	1	310000–31FFFF
SA50	0	1	1	0	0	1	0	320000-32FFFF
SA51	0	1	1	0	0	1	1	330000-33FFFF
SA52	0	1	1	0	1	0	0	340000-34FFFF
SA53	0	1	1	0	1	0	1	350000-35FFFF
SA54	0	1	1	0	1	1	0	360000-36FFFF
SA55	0	1	1	0	1	1	1	370000-37FFFF
SA56	0	1	1	1	0	0	0	380000–38FFFF
SA57	0	1	1	1	0	0	1	390000–39FFFF
SA58	0	1	1	1	0	1	0	3A0000-3AFFFF
SA59	0	1	1	1	0	1	1	3B0000-3BFFFF
SA60	0	1	1	1	1	0	0	3C0000-3CFFFF
SA61	0	1	1	1	1	0	1	3D0000-3DFFFF
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Table 2. Sector Address Table (Continued)

Sector	A22	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA62	0	1	1	1	1	1	0	3E0000-3EFFFF
SA63	0	1	1	1	1	1	1	3F0000-3FFFFF
SA64	1	0	0	0	0	0	0	400000-40FFFF
SA65	1	0	0	0	0	0	1	410000-41FFFF
SA66	1	0	0	0	0	1	0	420000-42FFFF
SA67	1	0	0	0	0	1	1	430000-43FFFF
SA68	1	0	0	0	1	0	0	440000-44FFFF
SA69	1	0	0	0	1	0	1	450000-45FFFF
SA70	1	0	0	0	1	1	0	460000-46FFFF
SA71	1	0	0	0	1	1	1	470000-47FFFF
SA72	1	0	0	1	0	0	0	480000-48FFFF
SA73	1	0	0	1	0	0	1	490000-49FFFF
SA74	1	0	0	1	0	1	0	4A0000-4AFFFF
SA75	1	0	0	1	0	1	1	4B0000-4BFFFF
SA76	1	0	0	1	1	0	0	4C0000-4CFFFF
SA77	1	0	0	1	1	0	1	4D0000-4DFFFF
SA78	1	0	0	1	1	1	0	4E0000-4EFFFF
SA79	1	0	0	1	1	1	1	4F0000-4FFFFF
SA80	1	0	1	0	0	0	0	500000-50FFFF
SA81	1	0	1	0	0	0	1	510000-51FFFF
SA82	1	0	1	0	0	1	0	520000-52FFFF
SA83	1	0	1	0	0	1	1	530000-53FFFF
SA84	1	0	1	0	1	0	0	540000-54FFFF
SA85	1	0	1	0	1	0	1	550000-55FFFF
SA86	1	0	1	0	1	1	0	560000-56FFFF
SA87	1	0	1	0	1	1	1	570000-57FFFF
SA88	1	0	1	1	0	0	0	580000-58FFFF
SA89	1	0	1	1	0	0	1	590000-59FFFF
SA90	1	0	1	1	0	1	0	5A0000-5AFFFF
SA91	1	0	1	1	0	1	1	5B0000-5BFFFF
SA92	1	0	1	1	1	0	0	5C0000-5CFFFF
SA93	1	0	1	1	1	0	1	5D0000-5DFFFF
SA94	1	0	1	1	1	1	0	5E0000-5EFFFF
SA95	1	0	1	1	1	1	1	5F0000-5FFFFF
SA96	1	1	0	0	0	0	0	600000-60FFFF



Table 2. Sector Address Table (Continued)

SA97         1         1         0         0         0         1         610000-61FFFF           SA98         1         1         0         0         0         1         0         620000-62FFFF           SA99         1         1         0         0         0         1         1         630000-63FFFF           SA100         1         1         0         0         1         0         640000-64FFFF           SA101         1         1         0         0         1         0         660000-65FFFF           SA102         1         1         0         0         1         1         0         660000-65FFFF           SA103         1         1         0         0         1         1         0         660000-65FFFF           SA104         1         1         0         1         0         0         680000-65FFFF           SA105         1         1         0         1         0         0         60000-65FFFF           SA106         1         1         0         1         0         1         69000-65FFF           SA107         1         1         0         1 </th <th>Sector</th> <th>A22</th> <th>A21</th> <th>A20</th> <th>A19</th> <th>A18</th> <th>A17</th> <th>A16</th> <th>8-bit Address Range (in hexadecimal)</th>	Sector	A22	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA99         1         1         0         0         0         1         1         630000-63FFFF           SA100         1         1         0         0         1         0         640000-64FFFF           SA101         1         1         0         0         1         0         1         650000-65FFFF           SA102         1         1         0         0         1         1         0         660000-65FFFF           SA103         1         1         0         0         1         1         1         670000-67FFFF           SA104         1         1         0         1         0         0         680000-68FFFF           SA105         1         1         0         1         0         0         640000-68FFFF           SA106         1         1         0         1         0         1         690000-68FFFF           SA107         1         1         0         1         0         1         680000-68FFFF           SA108         1         1         0         1         1         0         60000-6FFFF           SA109         1         1         0	SA97	1	1	0	0	0	0	1	610000-61FFFF
SA100         1         1         0         0         640000-64FFFF           SA101         1         1         0         0         1         0         660000-65FFFF           SA102         1         1         0         0         1         1         0         660000-65FFFF           SA103         1         1         0         0         1         1         670000-67FFFF           SA104         1         1         0         1         0         0         680000-68FFFF           SA105         1         1         0         1         0         0         680000-68FFFF           SA106         1         1         0         1         0         1         690000-68FFFF           SA107         1         1         0         1         0         660000-68FFFF           SA108         1         1         0         1         1         680000-68FFFF           SA108         1         1         0         1         1         0         660000-6EFFFF           SA109         1         1         0         1         1         0         1         60000-6EFFFF           SA110	SA98	1	1	0	0	0	1	0	620000-62FFFF
SA101         1         1         0         0         1         0         1         650000-65FFFF           SA102         1         1         0         0         1         1         0         660000-66FFFF           SA103         1         1         0         0         1         1         670000-67FFFF           SA104         1         1         0         1         0         0         680000-68FFFF           SA105         1         1         0         1         0         0         680000-68FFFF           SA106         1         1         0         1         0         1         690000-68FFFF           SA107         1         1         0         1         0         660000-68FFFF           SA108         1         1         0         1         1         680000-68FFFF           SA108         1         1         0         1         1         0         660000-68FFFF           SA109         1         1         0         1         1         0         0         66000-6FFFFF           SA110         1         1         0         1         1         0 <t< td=""><td>SA99</td><td>1</td><td>1</td><td>0</td><td>0</td><td>0</td><td>1</td><td>1</td><td>630000–63FFFF</td></t<>	SA99	1	1	0	0	0	1	1	630000–63FFFF
SA102         1         1         0         0         1         1         0         660000-66FFFF           SA103         1         1         0         0         1         1         1         670000-67FFFF           SA104         1         1         0         1         0         0         0         680000-68FFFF           SA105         1         1         0         1         0         0         1         690000-69FFFF           SA106         1         1         0         1         0         6A0000-68FFFF           SA107         1         1         0         1         0         6A0000-68FFFF           SA108         1         1         0         1         1         6B0000-6EFFFF           SA109         1         1         0         1         1         0         0         6C0000-6EFFFF           SA110         1         1         0         1         1         0         6E0000-6FFFF           SA111         1         1         0         1         1         1         0         6E0000-6FFFF           SA112         1         1         1         0 <td< td=""><td>SA100</td><td>1</td><td>1</td><td>0</td><td>0</td><td>1</td><td>0</td><td>0</td><td>640000-64FFFF</td></td<>	SA100	1	1	0	0	1	0	0	640000-64FFFF
SA103         1         1         0         0         1         1         1         670000-67FFFF           SA104         1         1         0         0         0         680000-68FFFF           SA105         1         1         0         1         0         0         1         690000-69FFFF           SA106         1         1         0         1         0         640000-6AFFFF           SA107         1         1         0         1         0         660000-6EFFFF           SA108         1         1         0         1         1         0         0         6C0000-6EFFFF           SA109         1         1         0         1         1         0         0         6C0000-6EFFFF           SA110         1         1         0         1         1         0         0         6E0000-6EFFFF           SA111         1         1         0         1         1         1         0         6E0000-6FFFFF           SA112         1         1         1         0         0         0         700000-7FFFF           SA113         1         1         1         0 <t< td=""><td>SA101</td><td>1</td><td>1</td><td>0</td><td>0</td><td>1</td><td>0</td><td>1</td><td>650000-65FFFF</td></t<>	SA101	1	1	0	0	1	0	1	650000-65FFFF
SA104         1         1         0         1         0         0         680000-68FFFF           SA105         1         1         0         1         0         0         1         690000-69FFFF           SA106         1         1         0         1         0         6A0000-6AFFFF           SA107         1         1         0         1         0         6E0000-6BFFFF           SA108         1         1         0         1         1         0         6E0000-6EFFFF           SA109         1         1         0         1         1         0         1         6E0000-6EFFFF           SA110         1         1         0         1         1         0         6E0000-6EFFFF           SA111         1         1         0         1         1         1         6F0000-6FFFFF           SA112         1         1         1         0         0         0         70000-72FFFF           SA113         1         1         1         0         0         0         720000-72FFF           SA114         1         1         1         0         0         1         730000-73FFFF	SA102	1	1	0	0	1	1	0	660000–66FFFF
SA105         1         1         0         1         0         0         1         690000-69FFFF           SA106         1         1         0         1         0         1         0         6A0000-6AFFFF           SA107         1         1         0         1         0         1         1         6B0000-6BFFFF           SA108         1         1         0         1         1         0         6C0000-6CFFFF           SA109         1         1         0         1         1         0         1         6D0000-6EFFFF           SA110         1         1         0         1         1         0         6E0000-6EFFFF           SA111         1         1         0         1         1         1         6F0000-6FFFFF           SA112         1         1         1         0         0         0         700000-70FFFF           SA113         1         1         1         0         0         0         720000-72FFFF           SA114         1         1         1         0         0         1         730000-73FFFF           SA115         1         1         1         <	SA103	1	1	0	0	1	1	1	670000–67FFFF
SA106         1         1         0         1         0         6A0000-6AFFFF           SA107         1         1         0         1         0         1         1         6B0000-6BFFFF           SA108         1         1         0         1         1         0         0         6C0000-6CFFFF           SA109         1         1         0         1         1         0         1         6D0000-6EFFFF           SA110         1         1         0         1         1         0         6E0000-6EFFFF           SA111         1         1         0         1         1         1         6F0000-6EFFFF           SA112         1         1         0         1         1         1         6F0000-6FFFFF           SA112         1         1         0         0         0         700000-70FFFF           SA113         1         1         1         0         0         1         710000-71FFFF           SA114         1         1         1         0         0         1         720000-72FFFF           SA115         1         1         1         0         0         1         <	SA104	1	1	0	1	0	0	0	680000–68FFFF
SA107         1         1         0         1         0         1         1         680000-6BFFFF           SA108         1         1         0         1         1         0         0         6C0000-6CFFFF           SA109         1         1         0         1         1         0         1         6D0000-6EFFFF           SA110         1         1         0         1         1         0         6E0000-6EFFFF           SA111         1         1         0         1         1         1         6F0000-6FFFFF           SA112         1         1         1         0         0         0         700000-70FFFF           SA113         1         1         1         0         0         0         700000-71FFFF           SA114         1         1         1         0         0         1         710000-72FFFF           SA115         1         1         1         0         0         1         730000-73FFF           SA116         1         1         1         0         1         0         740000-74FFF           SA117         1         1         1         0 <td< td=""><td>SA105</td><td>1</td><td>1</td><td>0</td><td>1</td><td>0</td><td>0</td><td>1</td><td>690000–69FFFF</td></td<>	SA105	1	1	0	1	0	0	1	690000–69FFFF
SA108         1         1         0         1         1         0         6C0000-6CFFFF           SA109         1         1         0         1         1         0         1         6D0000-6DFFFF           SA110         1         1         1         1         0         1         1         0         6E0000-6EFFFF           SA111         1         1         0         1         1         1         6F0000-6FFFFF           SA111         1         1         0         0         0         0         700000-70FFFF           SA112         1         1         1         0         0         0         700000-70FFFF           SA113         1         1         1         0         0         0         1         710000-71FFFF           SA114         1         1         1         0         0         1         720000-72FFFF           SA115         1         1         1         0         0         1         730000-73FFFF           SA116         1         1         1         0         1         750000-75FFFF           SA117         1         1         1         0         <	SA106	1	1	0	1	0	1	0	6A0000-6AFFFF
SA109         1         1         0         1         1         0         1         6D0000-6DFFFF           SA110         1         1         0         1         1         0         6E0000-6EFFFF           SA111         1         1         0         1         1         1         0         6E0000-6EFFFF           SA111         1         1         0         0         0         0         700000-70FFFF           SA112         1         1         1         0         0         0         700000-70FFFF           SA113         1         1         1         0         0         1         710000-71FFF           SA114         1         1         1         0         0         1         720000-72FFFF           SA115         1         1         1         0         0         1         730000-73FFFF           SA116         1         1         1         0         1         0         740000-74FFFF           SA117         1         1         1         0         1         0         760000-75FFFF           SA120         1         1         1         0         0 <t< td=""><td>SA107</td><td>1</td><td>1</td><td>0</td><td>1</td><td>0</td><td>1</td><td>1</td><td>6B0000-6BFFFF</td></t<>	SA107	1	1	0	1	0	1	1	6B0000-6BFFFF
SA110         1         1         0         1         1         1         0         6E0000-6EFFFF           SA111         1         1         1         1         1         1         6F0000-6FFFF           SA112         1         1         1         0         0         0         700000-70FFFF           SA113         1         1         1         0         0         0         1         710000-71FFFF           SA114         1         1         1         0         0         1         710000-72FFFF           SA115         1         1         1         0         0         1         1         730000-72FFFF           SA116         1         1         1         0         1         0         740000-73FFFF           SA118         1         1         1         0         1         0         760000-76FFFF           SA119         1         1         1         0         1         1         770000-77FFFF           SA120         1         1         1         0         0         780000-78FFFF           SA121         1         1         1         0         0 <t< td=""><td>SA108</td><td>1</td><td>1</td><td>0</td><td>1</td><td>1</td><td>0</td><td>0</td><td>6C0000-6CFFFF</td></t<>	SA108	1	1	0	1	1	0	0	6C0000-6CFFFF
SA111         1         1         1         1         1         6F0000-6FFFF           SA112         1         1         1         0         0         0         0         700000-70FFF           SA113         1         1         1         0         0         0         1         710000-71FFF           SA114         1         1         1         0         0         1         0         720000-72FFFF           SA115         1         1         1         0         0         1         1         730000-73FFFF           SA116         1         1         1         0         1         0         740000-74FFFF           SA117         1         1         1         0         1         0         750000-75FFF           SA118         1         1         1         0         1         1         750000-75FFF           SA119         1         1         1         0         1         1         770000-77FFFF           SA120         1         1         1         1         0         0         780000-78FFF           SA123         1         1         1         1         0 </td <td>SA109</td> <td>1</td> <td>1</td> <td>0</td> <td>1</td> <td>1</td> <td>0</td> <td>1</td> <td>6D0000-6DFFFF</td>	SA109	1	1	0	1	1	0	1	6D0000-6DFFFF
SA112         1         1         1         0         0         0         700000-70FFFF           SA113         1         1         1         0         0         0         1         710000-71FFFF           SA114         1         1         1         0         0         1         0         720000-72FFFF           SA115         1         1         1         0         0         1         1         730000-73FFFF           SA116         1         1         1         0         1         0         740000-73FFFF           SA117         1         1         1         0         1         0         750000-73FFFF           SA118         1         1         1         0         1         1         750000-75FFFF           SA119         1         1         1         0         1         1         770000-77FFFF           SA120         1         1         1         0         0         780000-78FFFF           SA121         1         1         1         0         0         700000-79FFFF           SA123         1         1         1         1         0         0         <	SA110	1	1	0	1	1	1	0	6E0000-6EFFFF
SA113         1         1         1         0         0         1         710000-71FFF           SA114         1         1         1         0         0         1         0         720000-72FFF           SA115         1         1         1         0         0         1         1         730000-73FFFF           SA116         1         1         1         0         1         0         740000-74FFFF           SA117         1         1         1         0         1         0         750000-75FFFF           SA118         1         1         1         0         1         1         750000-75FFFF           SA119         1         1         1         0         1         1         770000-77FFFF           SA120         1         1         1         1         0         0         780000-78FFFF           SA121         1         1         1         0         0         740000-79FFFF           SA123         1         1         1         1         0         1         780000-78FFFF           SA124         1         1         1         1         0         0 <td< td=""><td>SA111</td><td>1</td><td>1</td><td>0</td><td>1</td><td>1</td><td>1</td><td>1</td><td>6F0000-6FFFF</td></td<>	SA111	1	1	0	1	1	1	1	6F0000-6FFFF
SA114         1         1         1         0         0         1         0         720000-72FFFF           SA115         1         1         1         0         0         1         1         730000-73FFFF           SA116         1         1         1         0         1         0         740000-74FFFF           SA117         1         1         1         0         1         0         1         750000-75FFFF           SA118         1         1         1         0         1         1         0         760000-75FFFF           SA119         1         1         1         0         1         1         770000-77FFFF           SA120         1         1         1         1         0         0         780000-78FFFF           SA121         1         1         1         0         0         1         790000-79FFFF           SA122         1         1         1         0         1         0         760000-78FFFF           SA123         1         1         1         1         0         0         700000-70FFFF           SA125         1         1         1         <	SA112	1	1	1	0	0	0	0	700000-70FFFF
SA115         1         1         1         0         0         1         1         730000-73FFFF           SA116         1         1         1         0         1         0         740000-74FFFF           SA117         1         1         1         0         1         0         1         750000-75FFFF           SA118         1         1         1         0         1         1         0         760000-76FFFF           SA119         1         1         1         0         1         1         770000-77FFFF           SA120         1         1         1         1         0         0         780000-78FFFF           SA121         1         1         1         1         0         0         740000-78FFFF           SA122         1         1         1         1         0         1         780000-78FFFF           SA123         1         1         1         1         0         1         780000-78FFFF           SA124         1         1         1         1         0         0         7C0000-7CFFFF           SA126         1         1         1         1         <	SA113	1	1	1	0	0	0	1	710000–71FFFF
SA116         1         1         1         0         1         0         740000-74FFF           SA117         1         1         1         0         1         0         1         750000-75FFF           SA118         1         1         1         0         1         1         0         760000-76FFF           SA119         1         1         1         0         1         1         770000-77FFFF           SA120         1         1         1         0         0         0         780000-78FFFF           SA121         1         1         1         0         0         1         790000-79FFFF           SA122         1         1         1         0         1         0         740000-78FFFF           SA123         1         1         1         1         0         1         750000-75FFFF           SA124         1         1         1         1         0         0         750000-75FFFF           SA125         1         1         1         1         1         0         750000-75FFFF           SA126         1         1         1         1         1	SA114	1	1	1	0	0	1	0	720000-72FFFF
SA117         1         1         1         0         1         750000-75FFF           SA118         1         1         1         0         1         1         0         760000-76FFF           SA119         1         1         1         0         1         1         770000-77FFF           SA120         1         1         1         0         0         0         780000-78FFF           SA121         1         1         1         1         0         0         1         790000-79FFF           SA122         1         1         1         1         0         1         780000-78FFF           SA123         1         1         1         1         0         1         780000-78FFF           SA124         1         1         1         1         0         0         7C0000-7CFFFF           SA125         1         1         1         1         1         0         1         7D0000-7EFFFF           SA126         1         1         1         1         1         0         7E0000-7EFFFF	SA115	1	1	1	0	0	1	1	730000–73FFFF
SA118       1       1       1       0       1       1       0       760000-76FFF         SA119       1       1       1       0       1       1       1       770000-77FFF         SA120       1       1       1       1       0       0       0       780000-78FFF         SA121       1       1       1       1       0       0       1       790000-79FFF         SA122       1       1       1       1       0       1       0       740000-78FFF         SA123       1       1       1       1       0       1       750000-78FFF         SA124       1       1       1       1       0       0       700000-70FFFF         SA125       1       1       1       1       1       0       1       750000-70FFFF         SA126       1       1       1       1       1       0       760000-70FFFF	SA116	1	1	1	0	1	0	0	740000-74FFFF
SA119       1       1       1       0       1       1       1       770000-77FFFF         SA120       1       1       1       0       0       0       780000-78FFFF         SA121       1       1       1       1       0       0       1       790000-79FFFF         SA122       1       1       1       1       0       1       0       7A0000-7AFFFF         SA123       1       1       1       1       0       1       1       7B0000-7BFFFF         SA124       1       1       1       1       0       0       7C0000-7CFFFF         SA125       1       1       1       1       1       0       7E0000-7EFFFF	SA117	1	1	1	0	1	0	1	750000-75FFFF
SA120         1         1         1         1         0         0         0         780000-78FFFF           SA121         1         1         1         1         0         0         1         790000-79FFFF           SA122         1         1         1         1         0         1         0         7A0000-7AFFFF           SA123         1         1         1         1         0         1         1         7B0000-7BFFFF           SA124         1         1         1         1         0         0         7C0000-7CFFFF           SA125         1         1         1         1         1         0         1         7D0000-7DFFFF           SA126         1         1         1         1         1         0         7E0000-7EFFFF	SA118	1	1	1	0	1	1	0	760000-76FFFF
SA121       1       1       1       1       0       0       1       790000-79FFF         SA122       1       1       1       1       0       1       0       7A0000-7AFFF         SA123       1       1       1       1       0       1       1       7B0000-7BFFF         SA124       1       1       1       1       0       0       7C0000-7CFFFF         SA125       1       1       1       1       1       0       1       7D0000-7DFFFF         SA126       1       1       1       1       1       0       7E0000-7EFFFF	SA119	1	1	1	0	1	1	1	770000–77FFFF
SA122         1         1         1         1         0         1         0         7A0000-7AFFFF           SA123         1         1         1         1         0         1         1         7B0000-7BFFFF           SA124         1         1         1         1         0         0         7C0000-7CFFFF           SA125         1         1         1         1         0         1         7D0000-7DFFFF           SA126         1         1         1         1         1         0         7E0000-7EFFFF	SA120	1	1	1	1	0	0	0	780000–78FFFF
SA123         1         1         1         1         0         1         1         7B0000-7BFFF           SA124         1         1         1         1         0         0         7C0000-7CFFF           SA125         1         1         1         1         0         1         7D0000-7DFFF           SA126         1         1         1         1         1         0         7E0000-7EFFF	SA121	1	1	1	1	0	0	1	790000–79FFFF
SA124         1         1         1         1         0         0         7C0000-7CFFF           SA125         1         1         1         1         0         1         7D0000-7DFFF           SA126         1         1         1         1         1         0         7E0000-7EFFF	SA122	1	1	1	1	0	1	0	7A0000–7AFFFF
SA125         1         1         1         1         0         1         7D0000-7DFFF           SA126         1         1         1         1         1         0         7E0000-7EFFF	SA123	1	1	1	1	0	1	1	7B0000–7BFFFF
SA126 1 1 1 1 1 0 7E0000-7EFFFF	SA124	1	1	1	1	1	0	0	7C0000-7CFFFF
	SA125	1	1	1	1	1	0	1	7D0000-7DFFFF
	SA126	1	1	1	1	1	1	0	7E0000-7EFFFF
SA127   1   1   1   1   1   1   7F0000-7FFFFF	SA127	1	1	1	1	1	1	1	7F0000-7FFFF

Note: All sectors are 64 Kbytes in size.



#### **Autoselect Mode**

The autoselect mode provides manufacturer and device identification, and sector protection verification, through identifier codes output on DQ7–DQ0. This mode is primarily intended for programming equipment to automatically match a device to be programmed with its corresponding programming algorithm. However, the autoselect codes can also be accessed in-system through the command register.

When using programming equipment, the autoselect mode requires  $V_{ID}$  (8.5 V to 12.5 V) on address pin A9. Address pins A6, A1, and A0 must be as shown in

Table 3. In addition, when verifying sector protection, the sector address must appear on the appropriate highest order address bits (see Table 2). Table 3 shows the remaining address bits that are don't care. When all necessary bits have been set as required, the programming equipment may then read the corresponding identifier code on DQ7–DQ0.

To access the autoselect codes in-system, the host system can issue the autoselect command via the command register, as shown in Table 10. This method does not require  $V_{\rm ID}$ . Refer to the Autoselect Command Sequence section for more information.

Table 3. Am29LV065D Autoselect Codes, (High Voltage Method)

				A22 to	A15 to		A8 to		A5 to			
Description	CE#	OE#	WE#	A16	A10	A9	A7	A6	<b>A2</b>	<b>A</b> 1	Α0	DQ7 to DQ0
Manufacturer ID: AMD	L	L	Н	Х	Х	$V_{ID}$	Χ	L	Χ	L	L	01h
Device ID: Am29LV065D	L	L	Н	Х	Х	$V_{ID}$	Х	L	Χ	L	Н	93h
Sector Protection Verification	L	L	Н	SA	Х	V <sub>ID</sub>	Х	L	Х	Н	L	80h (protected), 00h (unprotected)
SecSi Sector Indicator Bit (DQ7)	L	L	Н	Х	Х	V <sub>ID</sub>	Х	L	Х	Η	Η	90h (factory locked), 10h (not factory locked)

**Legend:**  $L = Logic Low = V_{IL}$ ,  $H = Logic High = V_{IH}$ , SA = Sector Address, X = Don't care.



## Sector Group Protection and Unprotection

The hardware sector group protection feature disables both program and erase operations in any sector group. In this device, a sector group consists of four adjacent sectors that are protected or unprotected at the same time (see Table 4). The hardware sector group unprotection feature re-enables both program and erase operations in previously protected sector groups. Sector group protection/unprotection can be implemented via two methods.

Sector protection and unprotection requires  $V_{\rm ID}$  on the RESET# pin only, and can be implemented either in-system or via programming equipment. Figure 2 shows the algorithms and Figure 22 shows the timing diagram. This method uses standard microprocessor bus cycle timing. For sector group unprotect, all unprotected sector groups must first be protected prior to the first sector group unprotect write cycle.

The device is shipped with all sector groups unprotected. AMD offers the option of programming and protecting sector groups at its factory prior to shipping the device through AMD's ExpressFlash™ Service. Contact an AMD representative for details.

It is possible to determine whether a sector group is protected or unprotected. See the Autoselect Mode section for details.

Table 4. Sector Group Protection/Unprotection
Address Table

Sector Group	A22-A18
SA0-SA3	00000
SA4-SA7	00001
SA8-SA11	00010
SA12-SA15	00011
SA16-SA19	00100
SA20-SA23	00101
SA24-SA27	00110
SA28-SA31	00111
SA32-SA35	01000
SA36-SA39	01001
SA40-SA43	01010
SA44-SA47	01011
SA48-SA51	01100
SA52-SA55	01101
SA56-SA59	01110
SA60-SA63	01111
SA64-SA67	10000
SA68-SA71	10001
SA72-SA75	10010
SA76-SA79	10011
SA80-SA83	10100
SA84-SA87	10101
SA88-SA91	10110
SA92-SA95	10111
SA96-SA99	11000
SA100-SA103	11001
SA104-SA107	11010
SA108-SA111	11011
SA112-SA115	11100
SA116-SA119	11101
SA120-SA123	11110
SA124-SA127	11111

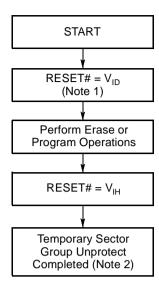
Note: All sector groups are 256 Kbytes in size.



## **Temporary Sector Group Unprotect**

(**Note:** In this device, a sector group consists of four adjacent sectors that are protected or unprotected at the same time (see *Table 4*)).

This feature allows temporary unprotection of previously protected sector groups to change data in-system. The Sector Group Unprotect mode is activated by setting the RESET# pin to  $V_{ID}$  (8.5 V – 12.5 V). During this mode, formerly protected sector groups can be programmed or erased by selecting the sector group addresses. Once  $V_{ID}$  is removed from the RESET# pin, all the previously protected sector groups are protected again. Figure 1 shows the algorithm, and Figure 21 shows the timing diagrams, for this feature.



- 1. All protected sector groups unprotected.
- 2. All previously protected sector groups are protected once again.

Figure 1. Temporary Sector Group Unprotect Operation



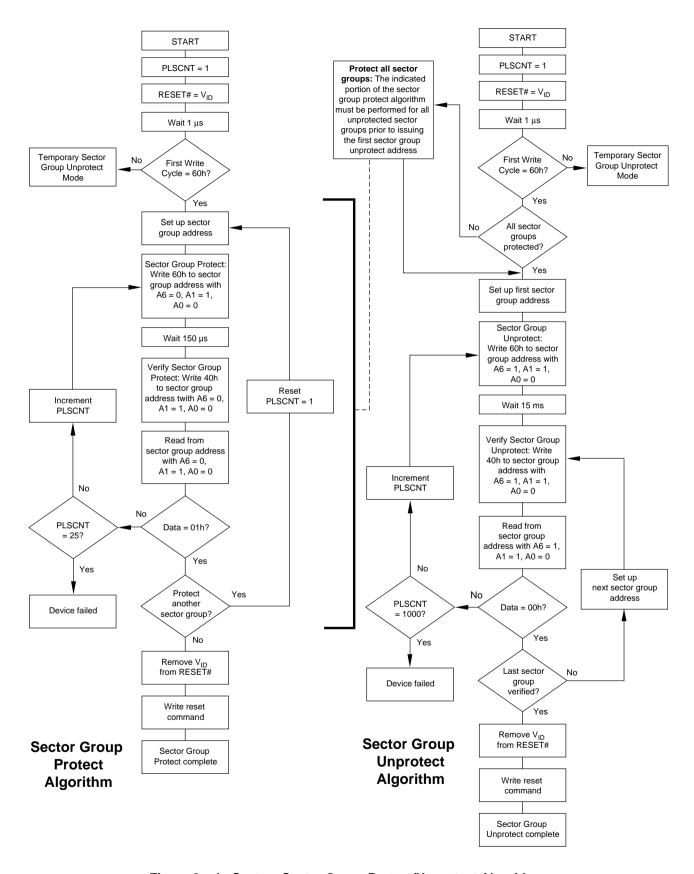


Figure 2. In-System Sector Group Protect/Unprotect Algorithms



## SecSi (Secured Silicon) Sector Flash Memory Region

The SecSi (Secured Silicon) Sector feature provides a Flash memory region that enables permanent part identification through an Electronic Serial Number (ESN). The SecSi Sector is 256 bytes in length, and uses a SecSi Sector Indicator Bit (DQ7) to indicate whether or not the SecSi Sector is locked when shipped from the factory. This bit is permanently set at the factory and cannot be changed, which prevents cloning of a factory locked part. This ensures the security of the ESN once the product is shipped to the field.

AMD offers the device with the SecSi Sector either factory locked or customer lockable. The factory-locked version is always protected when shipped from the factory, and has the SecSi (Secured Silicon) Sector Indicator Bit permanently set to a "1." The customer-lockable version is shipped with the SecSi Sector unprotected, allowing customers to utilize that sector in any manner they choose. The customer-lockable version also has the SecSi Sector Indicator Bit permanently set to a "0." Thus, the SecSi Sector Indicator Bit prevents customer-lockable devices from being used to replace devices that are factory locked.

The SecSi sector address space in this device is allocated as follows:

SecSi Sector Address Range	Standard Factory Locked	ExpressFlash Factory Locked	Customer Lockable
000000h-00000Fh	ESN	ESN or determined by customer	Determined by
000010h-00007Fh, 000400h-00047Fh	Unavailable	Determined by customer	customer

Table 5. SecSi Sector Contents

The system accesses the SecSi Sector through a command sequence (see "Enter SecSi Sector/Exit SecSi Sector Command Sequence"). After the system has written the Enter SecSi Sector command sequence, it may read the SecSi Sector by using the addresses normally occupied by the first sector (SA0). This mode of operation continues until the system issues the Exit SecSi Sector command sequence, or until power is removed from the device. On power-up, or following a hardware reset, the device reverts to sending commands to sector SA0.

## Factory Locked: SecSi Sector Programmed and Protected At the Factory

In devices with an ESN, the SecSi Sector is protected when the device is shipped from the factory. The SecSi Sector cannot be modified in any way. A factory locked device has an 16-byte random ESN at addresses 000000h–00000Fh.

Customers may opt to have their code programmed by AMD through the AMD ExpressFlash service. The devices are then shipped from AMD's factory with the SecSi Sector permanently locked. Contact an AMD representative for details on using AMD's Express-Flash service.

## Customer Lockable: SecSi Sector NOT Programmed or Protected At the Factory

As an alternative to the factory-locked version, the device may be ordered such that the customer may program and protect the 256-byte SecSi sector. The SecSi Sector is one-time programmable, may not be erased, and can be locked only once. Note that the accelerated programming (ACC) and unlock bypass functions are not available when programming the SecSi Sector.

The SecSi Sector area can be protected using one of the following procedures:

- Write the three-cycle Enter SecSi Sector Region command sequence, and then follow the in-system sector protect algorithm as shown in Figure 2, except that RESET# may be at either V<sub>IH</sub> or V<sub>ID</sub>. This allows in-system protection of the SecSi Sector without raising any device pin to a high voltage. Note that this method is only applicable to the SecSi Sector.
- Write the three-cycle Enter SecSi Sector Region command sequence, and then use the method of sector protection described in the "Sector Group Protection and Unprotection" section.

The SecSi Sector is one-time programmable. Once the SecSi Sector is programmed, locked and verified, the system must write the Exit SecSi Sector Region command sequence to return to reading and writing the remainder of the array.

The SecSi Sector protection must be used with caution since, once protected, there is no procedure available for unprotecting the SecSi Sector area and none of the bits in the SecSi Sector memory space can be modified in any way.

#### **Hardware Data Protection**

The command sequence requirement of unlock cycles for programming or erasing provides data protection against inadvertent writes (refer to Table 10 for command definitions). In addition, the following hardware data protection measures prevent accidental erasure or programming, which might otherwise be caused by spurious system level signals during  $V_{\rm CC}$  power-up and power-down transitions, or from system noise.

#### Low V<sub>CC</sub> Write Inhibit

When  $V_{CC}$  is less than  $V_{LKO}$ , the device does not accept any write cycles. This protects data during  $V_{CC}$  power-up and power-down. The command register and all internal program/erase circuits are disabled, and the device resets to the read mode. Subsequent



writes are ignored until  $V_{CC}$  is greater than  $V_{LKO}$ . The system must provide the proper signals to the control pins to prevent unintentional writes when  $V_{CC}$  is greater than  $V_{LKO}$ .

#### Write Pulse "Glitch" Protection

Noise pulses of less than 5 ns (typical) on OE#, CE# or WE# do not initiate a write cycle.

#### **Logical Inhibit**

Write cycles are inhibited by holding any one of OE# =  $V_{IL}$ , CE# =  $V_{IH}$  or WE# =  $V_{IH}$ . To initiate a write cycle, CE# and WE# must be a logical zero while OE# is a logical one.

#### **Power-Up Write Inhibit**

If WE# = CE# =  $V_{IL}$  and OE# =  $V_{IH}$  during power up, the device does not accept commands on the rising edge of WE#. The internal state machine is automatically reset to the read mode on power-up.

## **COMMON FLASH MEMORY INTERFACE (CFI)**

The Common Flash Interface (CFI) specification outlines device and host system software interrogation handshake, which allows specific vendor-specified software algorithms to be used for entire families of devices. Software support can then be device-independent, JEDEC ID-independent, and forward- and backward-compatible for the specified flash device families. Flash vendors can standardize their existing interfaces for long-term compatibility.

This device enters the CFI Query mode when the system writes the CFI Query command, 98h, any time the device is ready to read array data (addresses are don't care). The system can read CFI information at the ad-

dresses given in Tables 6–9. To terminate reading CFI data, the system must write the reset command.

The system can also write the CFI query command when the device is in the autoselect mode. The device enters the CFI query mode, and the system can read CFI data at the addresses given in Tables 6–9. The system must write the reset command to return the device to the autoselect mode.

For further information, please refer to the CFI Specification and CFI Publication 100, available via the World Wide Web at http://www.amd.com/products/nvd/overview/cfi.html. Alternatively, contact an AMD representative for copies of these documents.

Table 6. CFI Query Identification String

Addresses (x8)	Data	Description
10h 11h 12h	51h 52h 59h	Query Unique ASCII string "QRY"
13h 14h	02h 00h	Primary OEM Command Set
15h 16h	40h 00h	Address for Primary Extended Table
17h 18h	00h 00h	Alternate OEM Command Set (00h = none exists)
19h 1Ah	00h 00h	Address for Alternate OEM Extended Table (00h = none exists)



Table 7. System Interface String

Addresses (x8)	Data	Description
1Bh	27h	V <sub>CC</sub> Min. (write/erase) D7–D4: volt, D3–D0: 100 millivolt
1Ch	36h	V <sub>CC</sub> Max. (write/erase) D7–D4: volt, D3–D0: 100 millivolt
1Dh	00h	$V_{PP}$ Min. voltage (00h = no $V_{PP}$ pin present)
1Eh	00h	V <sub>PP</sub> Max. voltage (00h = no V <sub>PP</sub> pin present)
1Fh	04h	Typical timeout per single byte write 2 <sup>N</sup> µs
20h	00h	Typical timeout for Min. size buffer write $2^{N}$ µs (00h = not supported)
21h	0Ah	Typical timeout per individual block erase 2 <sup>N</sup> ms
22h	00h	Typical timeout for full chip erase 2 <sup>N</sup> ms (00h = not supported)
23h	05h	Max. timeout for byte write 2 <sup>N</sup> times typical
24h	00h	Max. timeout for buffer write 2 <sup>N</sup> times typical
25h	04h	Max. timeout per individual block erase 2 <sup>N</sup> times typical
26h	00h	Max. timeout for full chip erase 2 <sup>N</sup> times typical (00h = not supported)

## Table 8. Device Geometry Definition

Addresses (x8)	Data	Description
27h	17h	Device Size = 2 <sup>N</sup> byte
28h 29h	00h 00h	Flash Device Interface description (refer to CFI publication 100)
2Ah 2Bh	00h 00h	Max. number of bytes in multi-byte write = $2^N$ (00h = not supported)
2Ch	01h	Number of Erase Block Regions within device
2Dh 2Eh 2Fh 30h	7Fh 00h 00h 01h	Erase Block Region 1 Information (refer to the CFI specification or CFI publication 100)
31h 32h 33h 34h	00h 00h 00h 00h	Erase Block Region 2 Information (refer to CFI publication 100)
35h 36h 37h 38h	00h 00h 00h 00h	Erase Block Region 3 Information (refer to CFI publication 100)
39h 3Ah 3Bh 3Ch	00h 00h 00h 00h	Erase Block Region 4 Information (refer to CFI publication 100)

Table 9. Primary Vendor-Specific Extended Query

Addresses (x8)	Data	Description
40h 41h 42h	50h 52h 49h	Query-unique ASCII string "PRI"
43h	31h	Major version number, ASCII
44h	31h	Minor version number, ASCII
45h	01h	Address Sensitive Unlock (Bits 1-0) 0 = Required, 1 = Not Required Silicon Revision Number (Bits 7-2)
46h	02h	Erase Suspend 0 = Not Supported, 1 = To Read Only, 2 = To Read & Write
47h	04h	Sector Protect 0 = Not Supported, X = Number of sectors in per group
48h	01h	Sector Temporary Unprotect 00 = Not Supported, 01 = Supported
49h	04h	Sector Protect/Unprotect scheme 04 = 29LV800 mode
4Ah	00h	Simultaneous Operation 00 = Not Supported, X = Number of Sectors in Bank
4Bh	000h	Burst Mode Type 00 = Not Supported, 01 = Supported
4Ch	00h	Page Mode Type 00 = Not Supported
4Dh	B5h	ACC (Acceleration) Supply Minimum  00h = Not Supported, D7-D4: Volt, D3-D0: 100 mV
4Eh	C5h	ACC (Acceleration) Supply Maximum  00h = Not Supported, D7-D4: Volt, D3-D0: 100 mV
4Fh	00h	Top/Bottom Boot Sector Flag 02h = Bottom Boot Device, 03h = Top Boot Device

#### **COMMAND DEFINITIONS**

Writing specific address and data commands or sequences into the command register initiates device operations. Table 10 defines the valid register command sequences. Writing incorrect address and data values or writing them in the improper sequence resets the device to reading array data.

All addresses are latched on the falling edge of WE# or CE#, whichever happens later. All data is latched on the rising edge of WE# or CE#, whichever happens first. Refer to the AC Characteristics section for timing diagrams.

## **Reading Array Data**

The device is automatically set to reading array data after device power-up. No commands are required to retrieve data. The device is ready to read array data after completing an Embedded Program or Embedded Erase algorithm.

After the device accepts an Erase Suspend command, the device enters the erase-suspend-read mode, after which the system can read data from any non-erase-suspended sector. After completing a programming operation in the Erase Suspend mode, the system may once again read array data with the same exception. See the Erase Suspend/Erase Resume Commands section for more information.

The system *must* issue the reset command to return the device to the read (or erase-suspend-read) mode if DQ5 goes high during an active program or erase operation, or if the device is in the autoselect mode. See the next section, Reset Command, for more information.



See also "VersatileIO<sup>TM</sup> ( $V_{IO}$ ) Control" in the Device Bus Operations section for more information. The Read-Only Operations table provides the read parameters, and Figure 13 shows the timing diagram.

#### **Reset Command**

Writing the reset command resets the device to the read or erase-suspend-read mode. Address bits are don't cares for this command.

The reset command may be written between the sequence cycles in an erase command sequence before erasing begins. This resets the device to the read mode. Once erasure begins, however, the device ignores reset commands until the operation is complete.

The reset command may be written between the sequence cycles in a program command sequence before programming begins. This resets the device to the read mode. If the program command sequence is written while the device is in the Erase Suspend mode, writing the reset command returns the device to the erase-suspend-read mode. Once programming begins, however, the device ignores reset commands until the operation is complete.

The reset command may be written between the sequence cycles in an autoselect command sequence. Once in the autoselect mode, the reset command must be written to return to the read mode. If the device entered the autoselect mode while in the Erase Suspend mode, writing the reset command returns the device to the erase-suspend-read mode.

If DQ5 goes high during a program or erase operation, writing the reset command returns the device to the read mode (or erase-suspend-read mode if the device was in Erase Suspend).

#### **Autoselect Command Sequence**

The autoselect command sequence allows the host system to read several identifier codes at specific addresses:

Identifier Code	Address
Manufacturer ID	00h
Device ID	01h
SecSi Sector Factory Protect	03h
Sector Group Protect Verify	(SA)02h

Table 10 shows the address and data requirements. The command sequence is an alternative to the high voltage method shown in Table 3. The autoselect command sequence may be written to an address that is either in the read or erase-suspend-read mode. The autoselect command may not be written while the device is actively programming or erasing.

The autoselect command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle that contains the autoselect command. The

device then enters the autoselect mode. The system may read at any address any number of times without initiating another autoselect command sequence.

The system must write the reset command to return to the read mode (or erase-suspend-read mode if the device was previously in Erase Suspend).

## Enter SecSi Sector/Exit SecSi Sector Command Sequence

The SecSi Sector region provides a secured data area containing an 16-byte random Electronic Serial Number (ESN). The system can access the SecSi Sector region by issuing the three-cycle Enter SecSi Sector command sequence. The device continues to access the SecSi Sector region until the system issues the four-cycle Exit SecSi Sector command sequence. The Exit SecSi Sector command sequence returns the device to normal operation. Table 10 shows the address and data requirements for both command sequences. See also "SecSi (Secured Silicon) Sector Flash Memory Region" for further information.

## **Byte Program Command Sequence**

Programming is a four-bus-cycle operation. The program command sequence is initiated by writing two unlock write cycles, followed by the program set-up command. The program address and data are written next, which in turn initiate the Embedded Program algorithm. The system is *not* required to provide further controls or timings. The device automatically provides internally generated program pulses and verifies the programmed cell margin. Table 10 shows the address and data requirements for the byte program command sequence.

When the Embedded Program algorithm is complete, the device then returns to the read mode and addresses are no longer latched. The system can determine the status of the program operation by using DQ7, DQ6, or RY/BY#. Refer to the Write Operation Status section for information on these status bits.

Any commands written to the device during the Embedded Program Algorithm are ignored. Note that a **hardware reset** immediately terminates the program operation. The program command sequence should be reinitiated once the device has returned to the read mode, to ensure data integrity.

Programming is allowed in any sequence and across sector boundaries. A bit cannot be programmed from "0" back to a "1." Attempting to do so may cause the device to set DQ5 = 1, or cause the DQ7 and DQ6 status bits to indicate the operation was successful. However, a succeeding read will show that the data is still "0." Only erase operations can convert a "0" to a "1."



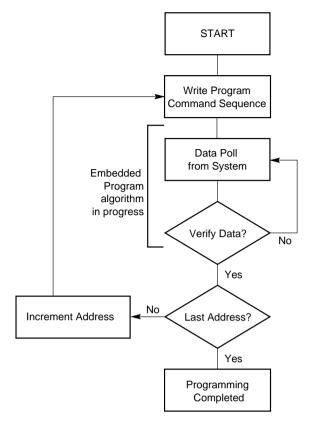
#### **Unlock Bypass Command Sequence**

The unlock bypass feature allows the system to program bytes to the device faster than using the standard program command sequence. The unlock bypass command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle containing the unlock bypass command, 20h. The device then enters the unlock bypass mode. A two-cycle unlock bypass program command sequence is all that is required to program in this mode. The first cycle in this sequence contains the unlock bypass program command, A0h; the second cycle contains the program address and data. Additional data is programmed in the same manner. This mode dispenses with the initial two unlock cycles required in the standard program command sequence, resulting in faster total programming time. Table 10 shows the requirements for the command sequence.

During the unlock bypass mode, only the Unlock Bypass Program and Unlock Bypass Reset commands are valid. To exit the unlock bypass mode, the system must issue the two-cycle unlock bypass reset command sequence. The first cycle must contain the data 90h. The second cycle must contain the data 00h. The device then returns to the read mode.

The device offers accelerated program operations through the ACC pin. When the system asserts  $V_{HH}$  on the ACC pin, the device automatically enters the Unlock Bypass mode. The system may then write the two-cycle Unlock Bypass program command sequence. The device uses the higher voltage on the ACC pin to accelerate the operation. Note that the ACC pin must not be at  $V_{HH}$  for operations other than accelerated programming, or device damage may result.

Figure 3 illustrates the algorithm for the program operation. Refer to the Erase and Program Operations table in the AC Characteristics section for parameters, and Figure 15 for timing diagrams.



Note: See Table 10 for program command sequence.

Figure 3. Program Operation

## **Chip Erase Command Sequence**

Chip erase is a six bus cycle operation. The chip erase command sequence is initiated by writing two unlock cycles, followed by a set-up command. Two additional unlock write cycles are then followed by the chip erase command, which in turn invokes the Embedded Erase algorithm. The device does *not* require the system to preprogram prior to erase. The Embedded Erase algorithm automatically preprograms and verifies the entire memory for an all zero data pattern prior to electrical erase. The system is not required to provide any controls or timings during these operations. Table 10 shows the address and data requirements for the chip erase command sequence.



When the Embedded Erase algorithm is complete, the device returns to the read mode and addresses are no longer latched. The system can determine the status of the erase operation by using DQ7, DQ6, DQ2, or RY/BY#. Refer to the Write Operation Status section for information on these status bits.

Any commands written during the chip erase operation are ignored. However, note that a **hardware reset** immediately terminates the erase operation. If that occurs, the chip erase command sequence should be reinitiated once the device has returned to reading array data, to ensure data integrity.

Figure 4 illustrates the algorithm for the erase operation. Refer to the Erase and Program Operations tables in the AC Characteristics section for parameters, and Figure 17 section for timing diagrams.

## **Sector Erase Command Sequence**

Sector erase is a six bus cycle operation. The sector erase command sequence is initiated by writing two unlock cycles, followed by a set-up command. Two additional unlock cycles are written, and are then followed by the address of the sector to be erased, and the sector erase command. Table 10 shows the address and data requirements for the sector erase command sequence.

The device does *not* require the system to preprogram prior to erase. The Embedded Erase algorithm automatically programs and verifies the entire memory for an all zero data pattern prior to electrical erase. The system is not required to provide any controls or timings during these operations.

After the command sequence is written, a sector erase time-out of 50 µs occurs. During the time-out period, additional sector addresses and sector erase commands may be written. Loading the sector erase buffer may be done in any sequence, and the number of sectors may be from one sector to all sectors. The time between these additional cycles must be less than 50 μs, otherwise erasure may begin. Any sector erase address and command following the exceeded time-out may or may not be accepted. It is recommended that processor interrupts be disabled during this time to ensure all commands are accepted. The interrupts can be re-enabled after the last Sector Erase command is written. Any command other than Sector Erase or Erase Suspend during the time-out period resets the device to the read mode. The system must rewrite the command sequence and any additional addresses and commands.

The system can monitor DQ3 to determine if the sector erase timer has timed out (See the section on DQ3: Sector Erase Timer.). The time-out begins from the rising edge of the final WE# pulse in the command sequence.

When the Embedded Erase algorithm is complete, the device returns to reading array data and addresses are no longer latched. Note that while the Embedded Erase operation is in progress, the system can read data from the non-erasing sector. The system can determine the status of the erase operation by reading DQ7, DQ6, DQ2, or RY/BY# in the erasing sector. Refer to the Write Operation Status section for information on these status bits.

Once the sector erase operation has begun, only the Erase Suspend command is valid. All other commands are ignored. However, note that a **hardware reset** immediately terminates the erase operation. If that occurs, the sector erase command sequence should be reinitiated once the device has returned to reading array data, to ensure data integrity.

Figure 4 illustrates the algorithm for the erase operation. Refer to the Erase and Program Operations tables in the AC Characteristics section for parameters, and Figure 17 section for timing diagrams.

## Erase Suspend/Erase Resume Commands

The Erase Suspend command, B0h, allows the system to interrupt a sector erase operation and then read data from, or program data to, any sector not selected for erasure. This command is valid only during the sector erase operation, including the 50 µs time-out period during the sector erase command sequence. The Erase Suspend command is ignored if written during the chip erase operation or Embedded Program algorithm.

When the Erase Suspend command is written during the sector erase operation, the device requires a maximum of 20  $\mu$ s to suspend the erase operation. However, when the Erase Suspend command is written during the sector erase time-out, the device immediately terminates the time-out period and suspends the erase operation.

After the erase operation has been suspended, the device enters the erase-suspend-read mode. The system can read data from or program data to any sector not selected for erasure. (The device "erase suspends" all sectors selected for erasure.) Reading at any address within erase-suspended sectors produces status information on DQ7–DQ0. The system can use DQ7, or DQ6 and DQ2 together, to determine if a sector is actively erasing or is erase-suspended. Refer to the Write Operation Status section for information on these status bits.

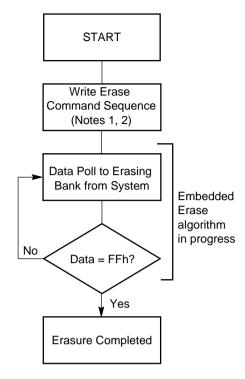
After an erase-suspended program operation is complete, the device returns to the erase-suspend-read mode. The system can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard byte program operation.



Refer to the Write Operation Status section for more information.

In the erase-suspend-read mode, the system can also issue the autoselect command sequence. Refer to the Autoselect Mode and Autoselect Command Sequence sections for details.

To resume the sector erase operation, the system must write the Erase Resume command. The address of the erase-suspended sector is required when writing this command. Further writes of the Resume command are ignored. Another Erase Suspend command can be written after the chip has resumed erasing.



- 1. See Table 10 for erase command sequence.
- See the section on DQ3 for information on the sector erase timer.

Figure 4. Erase Operation



#### **Command Definitions**

Table 10. Am29LV065D Command Definitions

Command		ý	Bus Cycles (Notes 2–4)											
	Sequence		First  Addr Data		Second Third		Fourth		Fifth		Sixth			
	(Note 1)	ઈ	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data
Read	(Note 5)	1	RA	RD										
Rese	t (Note 6)	1	XXX	F0										
7	Manufacturer ID	4	XXX	AA	XXX	55	XXX	90	X00	01				
ote	Device ID	4	XXX	AA	XXX	55	XXX	90	X01	93				
lect (N	SecSi Sector Factory Protect (Note 8)	4	XXX	AA	XXX	55	XXX	90	X03	80/00				
Autoselect (Note	Sector Group Protect Verify (Note 9)	4	XXX	AA	XXX	55	xxx	90	(SA)X02	00/01				
Enter SecSi Sector Region		3	XXX	AA	XXX	55	XXX	88						
Exit S	SecSi Sector Region	4	XXX	AA	XXX	55	XXX	90	XXX	00				
Progi	ram	4	XXX	AA	XXX	55	XXX	A0	PA	PD				
Unlo	ck Bypass	3	XXX	AA	XXX	55	XXX	20						
Unlo	ck Bypass Program (Note 10)	2	XXX	Α0	PA	PD								
Unlo	ck Bypass Reset (Note 11)	2	XXX	90	XXX	00								
Chip Erase		6	XXX	AA	XXX	55	XXX	80	XXX	AA	XXX	55	XXX	10
Sector Erase		6	XXX	AA	XXX	55	XXX	80	XXX	AA	XXX	55	SA	30
Erase Suspend (Note 12)		1	BA	В0										
Erase Resume (Note 13)		1	BA	30										
CFIC	Query (Note 14)	1	XX	98										

#### Legend:

X = Don't care

RA = Address of the memory location to be read.

RD = Data read from location RA during read operation.

PA = Address of the memory location to be programmed. Addresses latch on the falling edge of the WE# or CE# pulse, whichever happens later.

PD = Data to be programmed at location PA. Data latches on the rising edge of WE# or CE# pulse, whichever happens first.

SA = Address of the sector to be verified (in autoselect mode) or erased. Address bits A22–A16 uniquely select any sector.

- . See Table 1 for description of bus operations.
- 2. All values are in hexadecimal.
- Except for the read cycle and the fourth cycle of the autoselect command sequence, all bus cycles are write cycles.
- 4. Unless otherwise noted, address bits A22-A12 are don't cares.
- No unlock or command cycles required when device is in read mode
- The Reset command is required to return to the read mode (or to the erase-suspend-read mode if previously in Erase Suspend) when the device is in the autoselect mode, or if DQ5 goes high (while the device is providing status information).
- The fourth cycle of the autoselect command sequence is a read cycle. See the Autoselect Command Sequence section for more information.
- 8. The data is 80h for factory locked and 00h for not factory locked.

- The data is 00h for an unprotected sector group and 01h for a protected sector group.
- 10. The Unlock Bypass command is required prior to the Unlock Bypass Program command.
- 11. The Unlock Bypass Reset command is required to return to the read mode when the device is in the unlock bypass mode.
- 12. The system may read and program in non-erasing sectors, or enter the autoselect mode, when in the Erase Suspend mode. The Erase Suspend command is valid only during a sector erase operation.
- 13. The Erase Resume command is valid only during the Erase Suspend mode.
- Command is valid when device is ready to read array data or when device is in autoselect mode.



#### WRITE OPERATION STATUS

The device provides several bits to determine the status of a program or erase operation: DQ2, DQ3, DQ5, DQ6, and DQ7. Table 11 and the following subsections describe the function of these bits. DQ7 and DQ6 each offer a method for determining whether a program or erase operation is complete or in progress. The device also provides a hardware-based output signal, RY/BY#, to determine whether an Embedded Program or Erase operation is in progress or has been completed.

### **DQ7: Data# Polling**

The Data# Polling bit, DQ7, indicates to the host system whether an Embedded Program or Erase algorithm is in progress or completed, or whether the device is in Erase Suspend. Data# Polling is valid after the rising edge of the final WE# pulse in the command sequence.

During the Embedded Program algorithm, the device outputs on DQ7 the complement of the datum programmed to DQ7. This DQ7 status also applies to programming during Erase Suspend. When the Embedded Program algorithm is complete, the device outputs the datum programmed to DQ7. The system must provide the program address to read valid status information on DQ7. If a program address falls within a protected sector, Data# Polling on DQ7 is active for approximately 1 µs, then the device returns to the read mode.

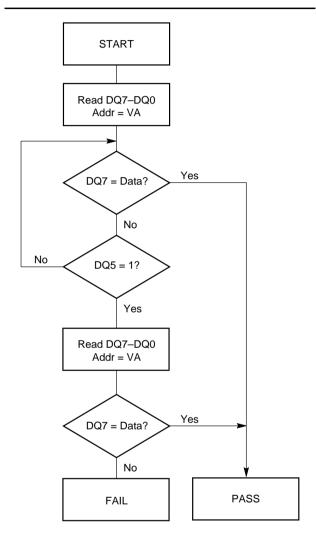
During the Embedded Erase algorithm, Data# Polling produces a "0" on DQ7. When the Embedded Erase algorithm is complete, or if the device enters the Erase Suspend mode, Data# Polling produces a "1" on DQ7. The system must provide an address within any of the sectors selected for erasure to read valid status information on DQ7.

After an erase command sequence is written, if all sectors selected for erasing are protected, Data# Polling on DQ7 is active for approximately 100 µs, then the device returns to the read mode. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected. However, if the system reads DQ7 at an address within a protected sector, the status may not be valid.

Just prior to the completion of an Embedded Program or Erase operation, DQ7 may change asynchronously with DQ0–DQ6 while Output Enable (OE#) is asserted low. That is, the device may change from providing status information to valid data on DQ7. Depending on when the system samples the DQ7 output, it may read the status or valid data. Even if the device has completed the program or erase operation and DQ7 has

valid data, the data outputs on DQ0–DQ6 may be still invalid. Valid data on DQ0–DQ7 will appear on successive read cycles.

Table 11 shows the outputs for Data# Polling on DQ7. Figure 5 shows the Data# Polling algorithm. Figure 18 in the AC Characteristics section shows the Data# Polling timing diagram.



- VA = Valid address for programming. During a sector erase operation, a valid address is any sector address within the sector being erased. During chip erase, a valid address is any non-protected sector address.
- DQ7 should be rechecked even if DQ5 = "1" because DQ7 may change simultaneously with DQ5.

Figure 5. Data# Polling Algorithm



## RY/BY#: Ready/Busy#

The RY/BY# is a dedicated, open-drain output pin which indicates whether an Embedded Algorithm is in progress or complete. The RY/BY# status is valid after the rising edge of the final WE# pulse in the command sequence. Since RY/BY# is an open-drain output, several RY/BY# pins can be tied together in parallel with a pull-up resistor to  $V_{\rm CC}$ .

If the output is low (Busy), the device is actively erasing or programming. (This includes programming in the Erase Suspend mode.) If the output is high (Ready), the device is in the read mode, the standby mode, or the device is in the erase-suspend-read mode.

Table 11 shows the outputs for RY/BY#.

## DQ6: Toggle Bit I

Toggle Bit I on DQ6 indicates whether an Embedded Program or Erase algorithm is in progress or complete, or whether the device has entered the Erase Suspend mode. Toggle Bit I may be read at any address, and is valid after the rising edge of the final WE# pulse in the command sequence (prior to the program or erase operation), and during the sector erase time-out.

During an Embedded Program or Erase algorithm operation, successive read cycles to any address cause DQ6 to toggle. The system may use either OE# or CE# to control the read cycles. When the operation is complete, DQ6 stops toggling.

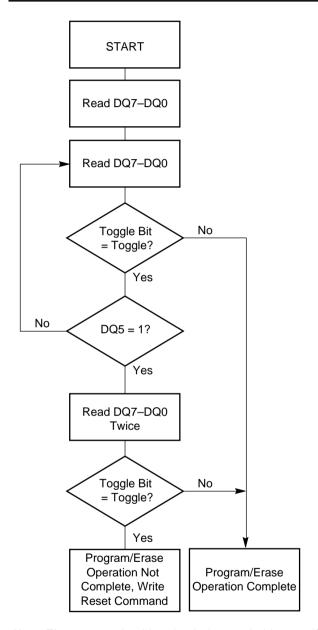
After an erase command sequence is written, if all sectors selected for erasing are protected, DQ6 toggles for approximately 100  $\mu$ s, then returns to reading array data. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected.

The system can use DQ6 and DQ2 together to determine whether a sector is actively erasing or is erase-suspended. When the device is actively erasing (that is, the Embedded Erase algorithm is in progress), DQ6 toggles. When the device enters the Erase Suspend mode, DQ6 stops toggling. However, the system must also use DQ2 to determine which sectors are erasing or erase-suspended. Alternatively, the system can use DQ7 (see the subsection on DQ7: Data# Polling).

If a program address falls within a protected sector, DQ6 toggles for approximately 1  $\mu$ s after the program command sequence is written, then returns to reading array data.

DQ6 also toggles during the erase-suspend-program mode, and stops toggling once the Embedded Program algorithm is complete.

Table 11 shows the outputs for Toggle Bit I on DQ6. Figure 6 shows the toggle bit algorithm. Figure 19 in the "AC Characteristics" section shows the toggle bit timing diagrams. Figure 20 shows the differences between DQ2 and DQ6 in graphical form. See also the subsection on DQ2: Toggle Bit II.



**Note:** The system should recheck the toggle bit even if DQ5 = "1" because the toggle bit may stop toggling as DQ5 changes to "1." See the subsections on DQ6 and DQ2 for more information.

Figure 6. Toggle Bit Algorithm



## DQ2: Toggle Bit II

The "Toggle Bit II" on DQ2, when used with DQ6, indicates whether a particular sector is actively erasing (that is, the Embedded Erase algorithm is in progress), or whether that sector is erase-suspended. Toggle Bit II is valid after the rising edge of the final WE# pulse in the command sequence.

DQ2 toggles when the system reads at addresses within those sectors that have been selected for erasure. (The system may use either OE# or CE# to control the read cycles.) But DQ2 cannot distinguish whether the sector is actively erasing or is erase-suspended. DQ6, by comparison, indicates whether the device is actively erasing, or is in Erase Suspend, but cannot distinguish which sectors are selected for erasure. Thus, both status bits are required for sector and mode information. Refer to Table 11 to compare outputs for DQ2 and DQ6.

Figure 6 shows the toggle bit algorithm in flowchart form, and the section "DQ2: Toggle Bit II" explains the algorithm. See also the DQ6: Toggle Bit I subsection. Figure 19 shows the toggle bit timing diagram. Figure 20 shows the differences between DQ2 and DQ6 in graphical form.

## Reading Toggle Bits DQ6/DQ2

Refer to Figure 6 for the following discussion. Whenever the system initially begins reading toggle bit status, it must read DQ7–DQ0 at least twice in a row to determine whether a toggle bit is toggling. Typically, the system would note and store the value of the toggle bit after the first read. After the second read, the system would compare the new value of the toggle bit with the first. If the toggle bit is not toggling, the device has completed the program or erase operation. The system can read array data on DQ7–DQ0 on the following read cycle.

However, if after the initial two read cycles, the system determines that the toggle bit is still toggling, the system also should note whether the value of DQ5 is high (see the section on DQ5). If it is, the system should then determine again whether the toggle bit is toggling, since the toggle bit may have stopped toggling just as DQ5 went high. If the toggle bit is no longer toggling, the device has successfully completed the program or erase operation. If it is still toggling, the device did not completed the operation successfully, and the system must write the reset command to return to reading array data.

The remaining scenario is that the system initially determines that the toggle bit is toggling and DQ5 has not gone high. The system may continue to monitor the toggle bit and DQ5 through successive read cycles, determining the status as described in the previous paragraph. Alternatively, it may choose to perform other system tasks. In this case, the system must start at the beginning of the algorithm when it returns to determine the status of the operation (top of Figure 6).

## **DQ5: Exceeded Timing Limits**

DQ5 indicates whether the program or erase time has exceeded a specified internal pulse count limit. Under these conditions DQ5 produces a "1," indicating that the program or erase cycle was not successfully completed.

The device may output a "1" on DQ5 if the system tries to program a "1" to a location that was previously programmed to "0." **Only an erase operation can change a "0" back to a "1."** Under this condition, the device halts the operation, and when the timing limit has been exceeded, DQ5 produces a "1."

Under both these conditions, the system must write the reset command to return to the read mode (or to the erase-suspend-read mode if the device was previously in the erase-suspend-program mode).

#### **DQ3: Sector Erase Timer**

After writing a sector erase command sequence, the system may read DQ3 to determine whether or not erasure has begun. (The sector erase timer does not apply to the chip erase command.) If additional sectors are selected for erasure, the entire time-out also applies after each additional sector erase command. When the time-out period is complete, DQ3 switches from a "0" to a "1." If the time between additional sector erase commands from the system can be assumed to be less than 50  $\mu s$ , the system need not monitor DQ3. See also the Sector Erase Command Sequence section.

After the sector erase command is written, the system should read the status of DQ7 (Data# Polling) or DQ6 (Toggle Bit I) to ensure that the device has accepted the command sequence, and then read DQ3. If DQ3 is "1," the Embedded Erase algorithm has begun; all further commands (except Erase Suspend) are ignored until the erase operation is complete. If DQ3 is "0," the device will accept additional sector erase commands. To ensure the command has been accepted, the system software should check the status of DQ3 prior to and following each subsequent sector erase command. If DQ3 is high on the second status check, the last command might not have been accepted.

Table 11 shows the status of DQ3 relative to the other status bits.



Table 11. Write Operation Status

Status			DQ7 (Note 2)	DQ6	DQ5 (Note 1)	DQ3	DQ2 (Note 2)	RY/BY#
Standard	Embedded Program Algorithm		DQ7#	Toggle	0	N/A	No toggle	0
Mode	Embedded Erase Algorithm		0	Toggle	0	1	Toggle	0
Erase	Erase-Suspend-	Erase Suspended Sector	1	No toggle	0	N/A	Toggle	1
Suspend Mode	Read	Non-Erase Suspended Sector	Data	Data	Data	Data	Data	1
	Erase-Suspend-Program		DQ7#	Toggle	0	N/A	N/A	0

- 1. DQ5 switches to '1' when an Embedded Program or Embedded Erase operation has exceeded the maximum timing limits. Refer to the section on DQ5 for more information.
- 2. DQ7 and DQ2 require a valid address when reading status information. Refer to the appropriate subsection for further details.

#### **ABSOLUTE MAXIMUM RATINGS**

Storage Temperature Plastic Packages65°C to +150°C
Ambient Temperature with Power Applied65°C to +125°C
Voltage with Respect to Ground
V <sub>CC</sub> (Note 1)0.5 V to +4.0 V
V <sub>IO</sub>
A9, OE#, ACC, and RESET#
(Note 2)0.5 V to +12.5 V
All other pins (Note 1) $-0.5$ V to $V_{CC}$ +0.5 V
Output Short Circuit Current (Note 3) 200 mA
Notes:

- 1. Minimum DC voltage on input or I/O pins is -0.5 V. During voltage transitions, input or I/O pins may overshoot  $V_{SS}$  to -2.0 V for periods of up to 20 ns. Maximum DC voltage on input or I/O pins is  $V_{CC}$  +0.5 V. See Figure 7. During voltage transitions, input or I/O pins may overshoot to  $V_{CC}$  +2.0 V for periods up to 20 ns. See Figure 8.
- Minimum DC input voltage on pins A9, OE#, ACC, and RESET# is -0.5 V. During voltage transitions, A9, OE#, ACC, and RESET# may overshoot V<sub>SS</sub> to -2.0 V for periods of up to 20 ns. See Figure 7. Maximum DC input voltage on pin A9, OE#, ACC, and RESET# is +12.5 V which may overshoot to +14.0 V for periods up to 20 ns.
- No more than one output may be shorted to ground at a time. Duration of the short circuit should not be greater than one second.

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational sections of this data sheet is not implied. Exposure of the device to absolute maximum rating conditions for extended periods may affect device reliability.

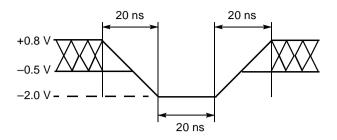


Figure 7. Maximum Negative Overshoot Waveform

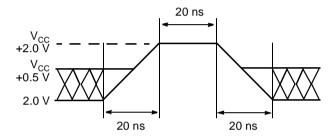


Figure 8. Maximum Positive Overshoot Waveform

#### **OPERATING RANGES**

#### Industrial (I) Devices

Ambient Temperature (T<sub>A</sub>) . . . . . . . . -40°C to +85°C

#### **Extended (E) Devices**

Ambient Temperature (T<sub>A</sub>) . . . . . . . -55°C to +125°C

#### **Supply Voltages**

Operating ranges define those limits between which the functionality of the device is guaranteed.



# DC CHARACTERISTICS CMOS Compatible

Parameter Symbol	Parameter Description	Test Conditio	ns	Min	Тур	Max	Unit
ILI	Input Load Current	$V_{IN} = V_{SS} \text{ to } V_{CC},$ $V_{CC} = V_{CC \text{ max}}$				±1.0	μA
I <sub>LIT</sub>	A9, ACC Input Load Current	$V_{CC} = V_{CC \text{ max}}; A9 = 12$	.5 V			35	μA
I <sub>LO</sub>	Output Leakage Current	$V_{OUT} = V_{SS}$ to $V_{CC}$ , $V_{CC} = V_{CC \text{ max}}$				±1.0	μA
I <sub>CC1</sub>	V <sub>CC</sub> Active Read Current (Notes 1, 2)	CE# = V <sub>IL,</sub> OE# <sub>=</sub> V <sub>IH</sub>	5 MHz 1 MHz		9	16 4	mA
I <sub>CC2</sub>	V <sub>CC</sub> Active Write Current (Notes 2, 3)	CE# = V <sub>11</sub> OE# _ V <sub>11</sub>	1 1011 12		26	30	mA
I <sub>CC3</sub>	V <sub>CC</sub> Standby Current (Note 2)	,	$CE\#, RESET\# = V_{CC} \pm 0.3 \text{ V}$		0.2	5	μA
I <sub>CC4</sub>	V <sub>CC</sub> Reset Current (Note 2)	RESET# = $V_{SS} \pm 0.3 \text{ V}$			0.2	5	μA
I <sub>CC5</sub>	Automatic Sleep Mode (Notes 2, 4)	$V_{IH} = V_{CC} \pm 0.3 \text{ V; } V_{IL} =$	V <sub>SS</sub> ± 0.3 V		0.2	5	μA
1	ACC Appelarated Program Coursest	CF# \/ OF# \/	ACC pin		5	10	mA
I <sub>ACC</sub>	ACC Accelerated Program Current	$CE# = V_{IL}, OE# = V_{IH}$	V <sub>CC</sub> pin		15	30	mA
$V_{IL}$	Input Low Voltage (Note 5)			-0.5		0.8	V
V <sub>IH</sub>	Input High Voltage (Note 5)			0.7 x V <sub>CC</sub>		V <sub>CC</sub> + 0.3	V
V <sub>HH</sub>	Voltage for ACC Program Acceleration	V <sub>CC</sub> = 3.0 V ± 10%		11.5		12.5	V
V <sub>ID</sub>	Voltage for Autoselect and Temporary Sector Unprotect	V <sub>CC</sub> = 3.0 V ± 10%		8.5		12.5	٧
V <sub>OL</sub>	Output Low Voltage	$I_{OL} = 4.0 \text{ mA}, V_{CC} = V_{CC \text{ min}}$				0.45	V
V <sub>OH1</sub>	Output High Voltage	$I_{OH} = -2.0 \text{ mA}, V_{CC} = V$	CC min	0.8 V <sub>IO</sub>			V
V <sub>OH2</sub>	Output High Voltage	$I_{OH} = -100 \ \mu A, \ V_{CC} = V$	CC min	V <sub>IO</sub> -0.4			V
$V_{LKO}$	Low V <sub>CC</sub> Lock-Out Voltage (Note 6)			2.3		2.5	V

- 1. The  $I_{\rm CC}$  current listed is typically less than 2 mA/MHz, with OE# at  $V_{\rm IH}$ .
- 2. Maximum  $I_{CC}$  specifications are tested with  $V_{CC} = V_{CC}$ max.
- 3.  $I_{CC}$  active while Embedded Erase or Embedded Program is in progress.
- Automatic sleep mode enables the low power mode when addresses remain stable for t<sub>ACC</sub> + 30 ns. Typical sleep mode current is 200 nA.
- 5. If  $V_{IO} < V_{CC}$ , maximum  $V_{IL}$  for CE# and DQ I/Os is 0.3  $V_{IO}$ . If  $V_{IO} < V_{CC}$ , minimum  $V_{IH}$  for CE# and DQ I/Os is 0.7  $V_{IO}$ . Maximum  $V_{IH}$  for these connections is  $V_{IO} + 0.3 V$ .
- 6. Not 100% tested.



## **DC CHARACTERISTICS**

### **Zero-Power Flash**

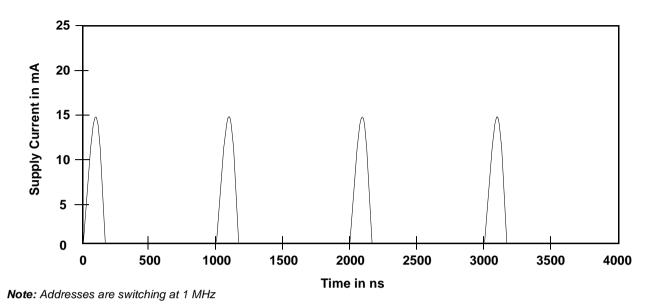


Figure 9. I<sub>CC1</sub> Current vs. Time (Showing Active and Automatic Sleep Currents)

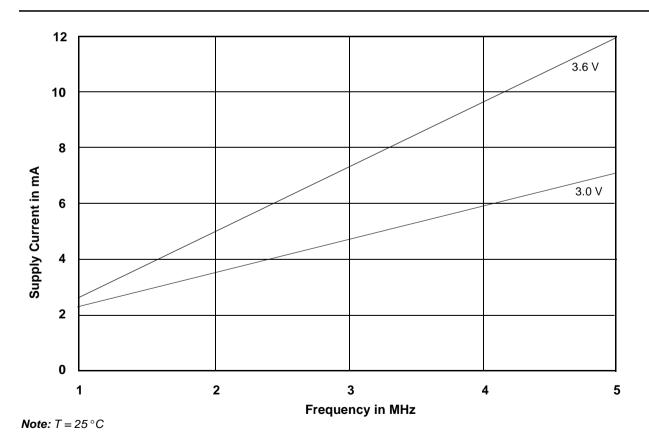


Figure 10. Typical I<sub>CC1</sub> vs. Frequency



### **TEST CONDITIONS**

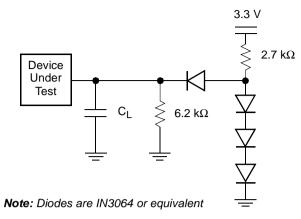


Figure 11. Test Setup

Table 12. Test Specifications

Test Condition	90R, 101R	120R, 121R	Unit
Output Load	1	TTL gate	
Output Load Capacitance, C <sub>L</sub> (including jig capacitance)	30	100	pF
Input Rise and Fall Times	5	ns	
Input Pulse Levels	0.0-	V	
Input timing measurement reference levels (See Note)	1.5		٧
Output timing measurement reference levels	0.5	V	

**Note:** If  $V_{IO} < V_{CC}$ , the reference level is 0.5  $V_{IO}$ .



**Note:** If  $V_{IO} < V_{CC}$ , the input measurement reference level is 0.5  $V_{IO}$ .

Figure 12. Input Waveforms and Measurement Levels

#### **KEY TO SWITCHING WAVEFORMS**

WAVEFORM	INPUTS	OUTPUTS					
	Steady						
	Changing from H to L						
	Changing from L to H						
XXXXXX	Don't Care, Any Change Permitted	Changing, State Unknown					
<b>&gt;&gt;</b>	Does Not Apply	Center Line is High Impedance State (High Z)					



# **Read-Only Operations**

Paran	neter					Speed Options			
JEDEC	Std.	Description		Test Setup (Note 1)		90R	101R	120R, 121R	Unit
t <sub>AVAV</sub>	t <sub>RC</sub>	Read Cycle Time (I	Note 2)		Min	90	100	120	ns
t <sub>AVQV</sub>	t <sub>ACC</sub>	Address to Output I	Delay	CE#, OE# = V <sub>IL</sub>	Max	90	100	120	ns
t <sub>ELQV</sub>	t <sub>CE</sub>	Chip Enable to Out	put Delay	OE# = V <sub>IL</sub>	Max	90	100	120	ns
t <sub>GLQV</sub>	t <sub>OE</sub>	Output Enable to Output Delay			Max	35	35	50	ns
t <sub>EHQZ</sub>	t <sub>DF</sub>	Chip Enable to Out	put High Z (Note 2)		Max	30	30	30	ns
t <sub>GHQZ</sub>	t <sub>DF</sub>	Output Enable to Output High Z (Note 2)			Max	30	30	30	ns
t <sub>AXQX</sub>	t <sub>OH</sub>	Output Hold Time From Addresses, CE# or OE#, Whichever Occurs First			Min	0			ns
		Read			Min		0		ns
	t <sub>OEH</sub>	Output Enable Hold Time (Note 2)	Toggle and Data# Polling		Min		10		ns

- 1. All test setups assume  $V_{IO} = V_{CC}$ .
- 2. Not 100% tested.
- 3. See Figure 11 and Table 12 for test specifications.

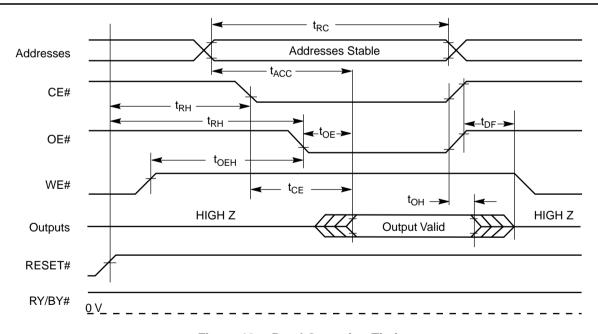


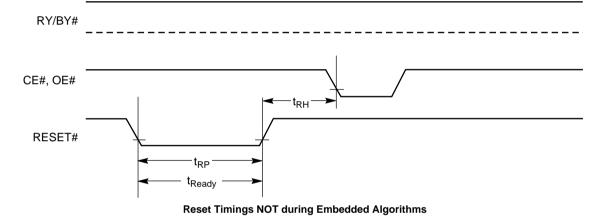
Figure 13. Read Operation Timings



# **Hardware Reset (RESET#)**

Parameter					
JEDEC	Std	Description		All Speed Options	Unit
	t <sub>Ready</sub>	RESET# Pin Low (During Embedded Algorithms) to Read Mode (See Note)	Max	20	μs
	t <sub>Ready</sub>	RESET# Pin Low (NOT During Embedded Algorithms) to Read Mode (See Note)	Max	500	ns
	t <sub>RP</sub>	RESET# Pulse Width	Min	500	ns
	t <sub>RH</sub>	Reset High Time Before Read (See Note)	Min	50	ns
	t <sub>RPD</sub>	RESET# Low to Standby Mode	Min	20	μs
	t <sub>RB</sub>	RY/BY# Recovery Time	Min	0	ns

Note: Not 100% tested.



Reset Timings during Embedded Algorithms

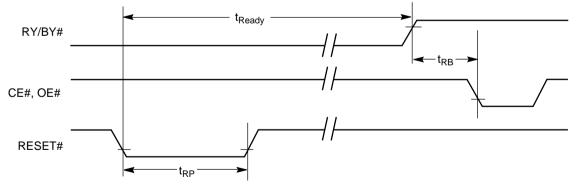


Figure 14. Reset Timings

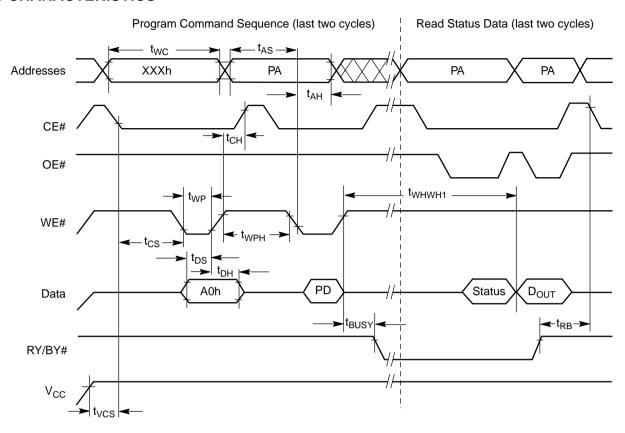


# **Erase and Program Operations**

Parameter				Sp	eed Opti	ons	
JEDEC	Std.	Description		90R	101R	120R, 121R	Unit
t <sub>AVAV</sub>	t <sub>WC</sub>	Write Cycle Time (Note 1)	Min	90	100	120	ns
t <sub>AVWL</sub>	t <sub>AS</sub>	Address Setup Time	Min		0		ns
	t <sub>ASO</sub>	Address Setup Time to OE# low during toggle bit polling	Min		15		ns
t <sub>WLAX</sub>	t <sub>AH</sub>	Address Hold Time	Min	45	45	50	ns
	t <sub>AHT</sub>	Address Hold Time From CE# or OE# high during toggle bit polling	Min		0		ns
t <sub>DVWH</sub>	t <sub>DS</sub>	Data Setup Time	Min	45	45	50	ns
t <sub>WHDX</sub>	t <sub>DH</sub>	Data Hold Time	Min		0		ns
	t <sub>OEPH</sub>	Output Enable High during toggle bit polling	Min	20			ns
t <sub>GHWL</sub>	t <sub>GHWL</sub>	Read Recovery Time Before Write (OE# High to WE# Low)	Min	0			ns
t <sub>ELWL</sub>	t <sub>CS</sub>	CE# Setup Time	Min		0		ns
t <sub>WHEH</sub>	t <sub>CH</sub>	CE# Hold Time	Min		0		ns
t <sub>WLWH</sub>	t <sub>WP</sub>	Write Pulse Width	Min	35	35	50	ns
t <sub>WHDL</sub>	t <sub>WPH</sub>	Write Pulse Width High	Min		30		ns
t <sub>WHWH1</sub>	t <sub>WHWH1</sub>	Byte Programming Operation (Note 2)	Тур		5		μs
t <sub>WHWH1</sub>	t <sub>WHWH1</sub>	Accelerated Byte Programming Operation (Note 2)	Тур		4		μs
t <sub>WHWH2</sub>	t <sub>WHWH2</sub>	Sector Erase Operation (Note 2)	Тур	0.9			sec
	t <sub>VHH</sub>	V <sub>HH</sub> Rise and Fall Time (Note 1)	Min	250		_	ns
	t <sub>VCS</sub>	V <sub>CC</sub> Setup Time (Note 1)	Min	50			μs
	t <sub>RB</sub>	Write Recovery Time from RY/BY#	Min	0			ns
	t <sub>BUSY</sub>	Program/Erase Valid to RY/BY# Delay	Max		90		ns

- 1. Not 100% tested.
- 2. See the "Erase And Programming Performance" section for more information.





**Note:**  $PA = program \ address$ ,  $PD = program \ data$ ,  $D_{OUT}$  is the true data at the program address.

Figure 15. Program Operation Timings

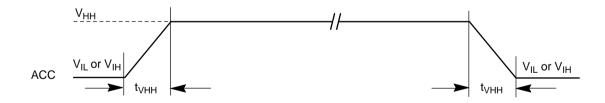
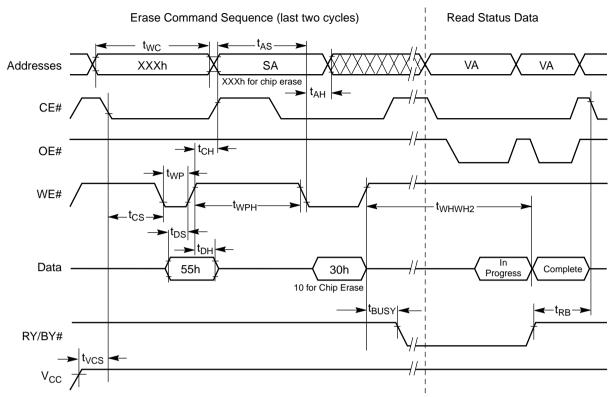


Figure 16. Accelerated Program Timing Diagram

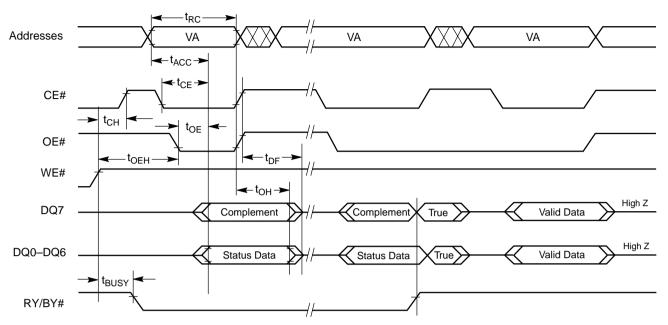




Note: SA = sector address (for Sector Erase), VA = Valid Address for reading status data (see "Write Operation Status"...

Figure 17. Chip/Sector Erase Operation Timings

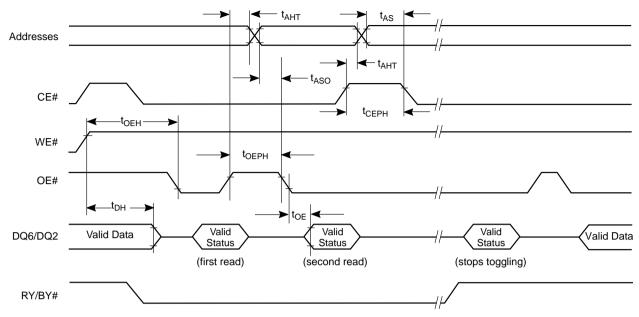




**Note:** VA = Valid address. Illustration shows first status cycle after command sequence, last status read cycle, and array data read cycle.

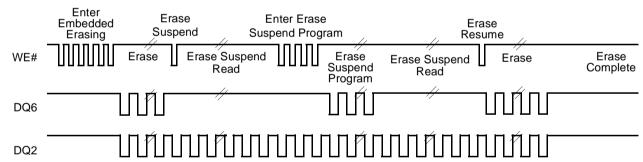
Figure 18. Data# Polling Timings (During Embedded Algorithms)





**Note:** VA = Valid address; not required for DQ6. Illustration shows first two status cycle after command sequence, last status read cycle, and array data read cycle

Figure 19. Toggle Bit Timings (During Embedded Algorithms)



**Note:** DQ2 toggles only when read at an address within an erase-suspended sector. The system may use OE# or CE# to toggle DQ2 and DQ6.

Figure 20. DQ2 vs. DQ6



# **Temporary Sector Unprotect**

Parameter					
JEDEC	Std	Description		All Speed Options	Unit
	t <sub>VIDR</sub>	V <sub>ID</sub> Rise and Fall Time (See Note)	Min	500	ns
	t <sub>RSP</sub>	RESET# Setup Time for Temporary Sector Unprotect	Min	4	μs
	t <sub>RRB</sub>	RESET# Hold Time from RY/BY# High for Temporary Sector Group Unprotect	Min	4	μs

Note: Not 100% tested.

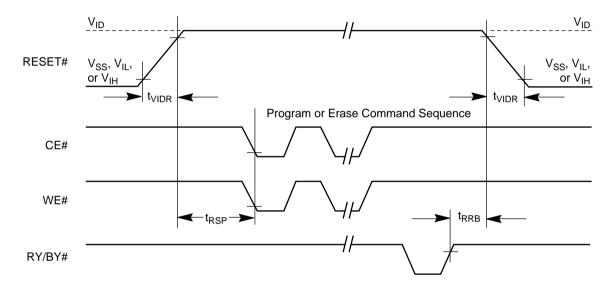
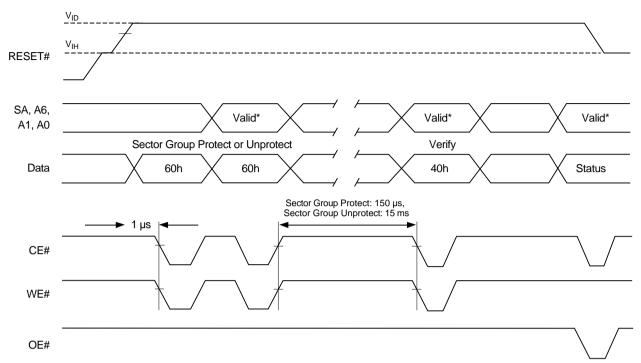


Figure 21. Temporary Sector Group Unprotect Timing Diagram





<sup>\*</sup> For sector group protect, A6 = 0, A1 = 1, A0 = 0. For sector group unprotect, A6 = 1, A1 = 1, A0 = 0.

Figure 22. Sector Group Protect and Unprotect Timing Diagram



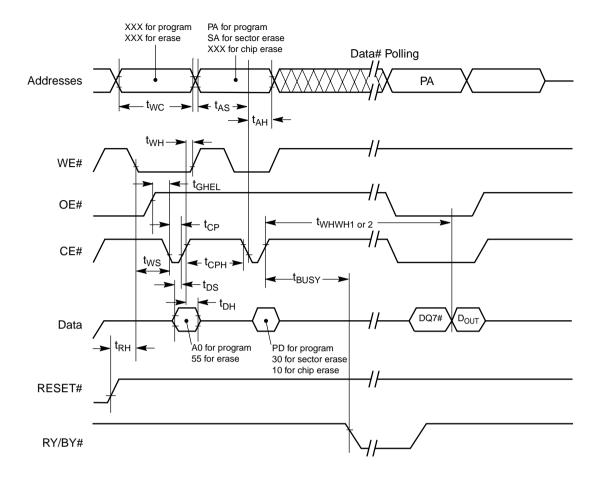
# **Alternate CE# Controlled Erase and Program Operations**

Parameter				Sp	eed Optio	ns	
JEDEC	Std	Description		90R	101R	120R	Unit
t <sub>AVAV</sub>	t <sub>WC</sub>	Write Cycle Time (Note 1)	Min	90	100	120	ns
t <sub>AVWL</sub>	t <sub>AS</sub>	Address Setup Time	Min		0		ns
t <sub>ELAX</sub>	t <sub>AH</sub>	Address Hold Time	Min	45	45	50	ns
t <sub>DVEH</sub>	t <sub>DS</sub>	Data Setup Time	Min	45	45	50	ns
t <sub>EHDX</sub>	t <sub>DH</sub>	Data Hold Time	Min		0		ns
t <sub>GHEL</sub>	t <sub>GHEL</sub>	Read Recovery Time Before Write (OE# High to WE# Low)	Min		0		ns
t <sub>WLEL</sub>	t <sub>WS</sub>	WE# Setup Time	Min		0		ns
t <sub>EHWH</sub>	t <sub>WH</sub>	WE# Hold Time	Min		0		ns
t <sub>ELEH</sub>	t <sub>CP</sub>	CE# Pulse Width	Min	45	45	50	ns
t <sub>EHEL</sub>	t <sub>CPH</sub>	CE# Pulse Width High	Min		30		ns
t <sub>WHWH1</sub>	t <sub>WHWH1</sub>	Byte Programming Operation (Note 2)	Тур	11		μs	
t <sub>WHWH1</sub>	t <sub>WHWH1</sub>	Accelerated Byte Programming Operation (Note 2)	Тур	7		μs	
t <sub>WHWH2</sub>	t <sub>WHWH2</sub>	Sector Erase Operation (Note 2)	Тур		0.9		sec

<sup>1.</sup> Not 100% tested.

<sup>2.</sup> See the "Erase And Programming Performance" section for more information.





- 1. Figure indicates last two bus cycles of a program or erase operation.
- 2. PA = program address, SA = sector address, PD = program data.
- 3. DQ7# is the complement of the data written to the device.  $D_{OUT}$  is the data written to the device.

Figure 23. Alternate CE# Controlled Write (Erase/Program) Operation Timings

## **ERASE AND PROGRAMMING PERFORMANCE**

Parameter	Typ (Note 1)	Max (Note 2)	Unit	Comments
Sector Erase Time	0.9	15	sec	Excludes 00h programming
Chip Erase Time	115		sec	prior to erasure (Note 4)
Byte Program Time	5	150	μs	
Accelerated Byte Program Time	4	120	μs	Excludes system level overhead (Note 5)
Chip Program Time (Note 3)	42	126	sec	(1000)

#### Notes:

- 1. Typical program and erase times assume the following conditions:  $25^{\circ}$ C, 3.0 V  $V_{CC}$ , 1,000,000 cycles. Additionally, programming typicals assume checkerboard pattern.
- 2. Under worst case conditions of  $90^{\circ}$  C,  $V_{CC} = 3.0$  V, 1,000,000 cycles.
- 3. The typical chip programming time is considerably less than the maximum chip programming time listed, since most bytes program faster than the maximum program times listed.
- 4. In the pre-programming step of the Embedded Erase algorithm, all bits are programmed to 00h before erasure.
- 5. System-level overhead is the time required to execute the two- or four-bus-cycle sequence for the program command. See Table 10 for further information on command definitions.
- 6. The device has a minimum erase and program cycle endurance of 1,000,000 cycles.

#### LATCHUP CHARACTERISTICS

Description	Min	Max
Input voltage with respect to $V_{\rm SS}$ on all pins except I/O pins (including A9, OE#, and RESET#)	–1.0 V	12.5 V
Input voltage with respect to V <sub>SS</sub> on all I/O pins	-1.0 V	V <sub>CC</sub> + 1.0 V
V <sub>CC</sub> Current	–100 mA	+100 mA

**Note:** Includes all pins except  $V_{CC}$ . Test conditions:  $V_{CC} = 3.0 \text{ V}$ , one pin at a time.

## **TSOP PIN CAPACITANCE**

Parameter Symbol	Parameter Description	Test Setup	Тур	Max	Unit
C <sub>IN</sub>	Input Capacitance	V <sub>IN</sub> = 0	6	7.5	pF
C <sub>OUT</sub>	Output Capacitance	$V_{OUT} = 0$	8.5	12	pF
C <sub>IN2</sub>	Control Pin Capacitance	V <sub>IN</sub> = 0	7.5	9	pF

#### Notes:

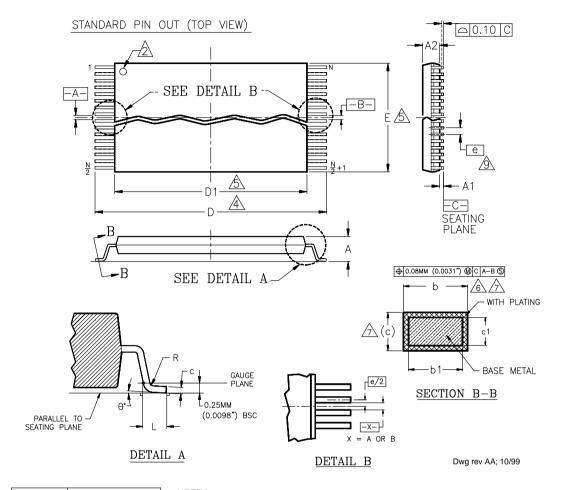
- 1. Sampled, not 100% tested.
- 2. Test conditions  $T_A = 25$ °C, f = 1.0 MHz.

## **DATA RETENTION**

Parameter Description	Test Conditions	Min	Unit
Minimum Dettern Deta Detention Time	150°C	10	Years
Minimum Pattern Data Retention Time	125°C	20	Years

#### PHYSICAL DIMENSIONS

## TS 048—48-Pin Standard Pinout Thin Small Outline Package (TSOP)



Package	TS 48				
Jedec	мо-	142 (I	3) DD		
Symbol	MIN	NDM	MAX		
Α	_	_	1.20		
A1	0.05	_	0.15		
A2	0.95	1.00	1.05		
b1	0.17	0.20	0.23		
b	0.17	0.22	0.27		
⊂1	0.10	_	0.16		
С	0.10	_	0.21		
D	19.80	20.00	20.20		
D1	18.30	18.40	18.50		
E	11.90	12.00	12.10		
е	0.5	50 BAS	IC		
L	0.50	0.60	0.70		
θ	0°	3°	5°		
R	0.08	_	0.20		
N		48			

#### NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (mm). (DIMENSIONING AND TOLERANCING CONFORMS TO ANSI Y14.5M-1982)

🛕 PIN 1 IDENTIFIER FOR STANDARD PIN OUT (DIE UP).

3 PIN 1 IDENTIFIER FOR REVERSE PIN DUT (DIE DOWN): INK OR LASER MARK.

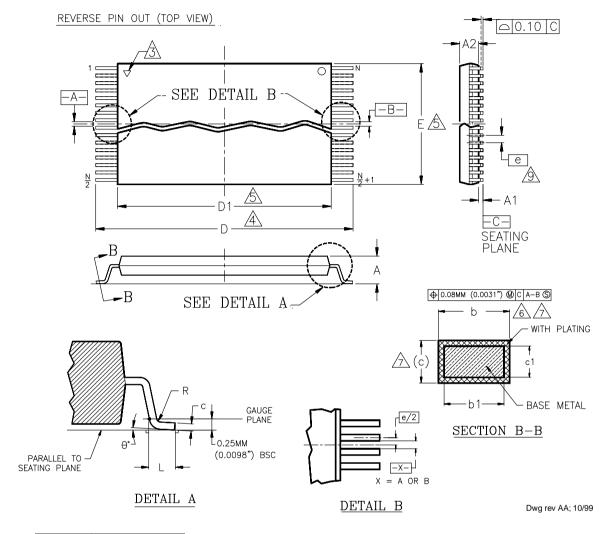
10 BE DETERMINED AT THE SEATING PLANE -C-. THE SEATING PLANE IS DEFINED AS THE PLANE OF CONTACT THAT IS MADE WHEN THE PACKAGE LEADS ARE ALLOWED TO REST FREELY ON A FLAT HORIZONTAL SURFACE.

- 5\ DIMENSIONS D1 AND E DO NOT INCLUDE MOLD PROTRUSION, ALLOWABLE MOLD PROTUSION IS 0.15mm (.0059") PER SIDE.
- PROTUSION SHALL BE 0.08mm (0.0031") TOTAL IN EXCESS OF 6 DIMENSION AT MAX. MATERIAL CONDITION, MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD TO BE 0.07mm (0.0028").
- /7.\ THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm (.0039") AND 0.25mm (0.0098") FROM THE LEAD TIP.
- 8. LEAD COPLANARITY SHALL BE WITHIN 0.10mm (0.004") AS MEASURED FROM THE SEATING PLANE.
- DIMENSION "e" IS MEASURED AT THE CENTERLINE OF THE LEADS.



#### PHYSICAL DIMENSIONS

## TSR048—48-Pin Reverse Pinout Thin Small Outline Package (TSOP)



Package	TSR 48					
Jedec	мо-	MO-142 (B) DD				
Symbol	MIN	NDM	MAX			
А	_	_	1.20			
A1	0.05		0.15			
A2	0.95	1.00	1.05			
b1	0.17	0.20	0.23			
b	0.17	0.22	0.27			
⊂1	0.10	-	0.16			
С	0.10		0.21			
D	19.80	20.00	20.20			
D1	18.30	18.40	18.50			
E	11.90	12.00	12.10			
е	0.5	50 BAS	IC			
L	0.50	0.60	0.70			
θ	0.	3°	5°			
R	0.08	_	0.20			
N		48				

#### NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (mm).

(DIMENSIONING AND TOLERANCING CONFORMS TO ANSI Y14.5M-1982)

PIN 1 IDENTIFIER FOR STANDARD PIN OUT (DIE UP).

PIN 1 IDENTIFIER FOR REVERSE PIN DUT (DIE DOWN); INK OR LASER MARK.

TO BE DETERMINED AT THE SEATING PLANE <u>-C-</u>. THE SEATING PLANE IS
DEFINED AS THE PLANE OF CONTACT THAT IS MADE WHEN THE PACKAGE LEADS
ARE ALLOWED TO REST FREELY ON A FLAT HORIZONTAL SURFACE.

DIMENSIONS DI AND E DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTUSION IS 0.15mm (.0059\*) PER SIDE.

DIMENSION 6 DOES NOT INCLUDE DAMBAR PROTUSION. ALLOWABLE DAMBAR PROTUSION SHALL BE 0.08mm (0.0031") TOTAL IN EXCESS OF 6 DIMENSION AT MAX. MATERIAL CONDITION, MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD TO BE 0.07mm (0.0028").

THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm (.0039\*) AND 0.25mm (0.0098\*) FROM THE LEAD TIP.

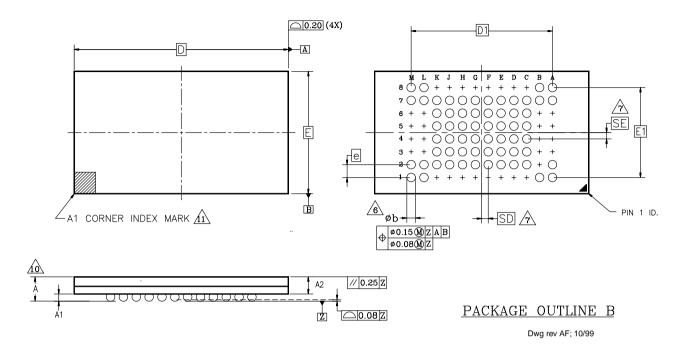
8. LEAD COPLANARITY SHALL BE WITHIN 0.10mm (0.004') AS MEASURED FROM THE SEATING PLANE.

DIMENSION "e" IS MEASURED AT THE CENTERLINE OF THE LEADS.



#### PHYSICAL DIMENSIONS

# FBE063—63-Ball Fine-Pitch Ball Grid Array (FBGA) 11 x 12 mm package



PACKAGE	хF	BE 063	3			
JEDEC	N/A					
		mmx11. PACKAG				
SYMBOL	MIN	NOM	MAX	NOTE		
Α	_	_	1.20	OVERALL THICKNESS		
A1	0.20	_	_	BALL HEIGHT		
A2	0.84	_	0.94	BODY THICKNESS		
D	12.	.00 BS	С	BODY SIZE		
E	11	.00 BS	С	BODY SIZE		
D1	8	.80 BS	С	BALL FOOTPRINT		
E1	5	.60 BS	С	BALL FOOTPRINT		
MD		12		ROW MATRIX SIZE D DIRECTION		
ME		8		ROW MATRIX SIZE E DIRECTION		
N		63		TOTAL BALL COUNT		
b	0.25	0.30	0.35	BALL DIAMETER		
е	0.80 BSC			BALL PITCH		
SD/SE	0.40 BSC		С	SOLDER BALL PLACEMENT		
	A3-A6,B2-B6 L3-L6, M3-M6 C1-K1,C8-K8			DEPOPULATED SOLDER BALLS		

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.
- 3. BALL POSITION DESIGNATION PER JESD 95-1, SPP-010.
- 4. e REPRESENTS THE SOLDER BALL GRID PITCH.
- 5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D"
  DIRECTION. SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE
  IN THE "E" DIRECTION. N IS THE MAXIMUM NUMBER OF SOLDER
  BALLS FOR MATRIX SIZE MD x ME.
- $\sum$  DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM Z.
- SD AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW. WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE = 0.000 WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = e/2
- 8. "X" IN THE PACKAGE VARIATIONS DENOTES PART IS UNDER QUALIFICATION.
- 9. "+" IN THE PACKAGE DRAWING INDICATE THE THEORETICAL CENTER OF DEPOPULATED BALLS.
- for package thickness a is the controling dimension.
  - A1 CORNER TO BE IDENTIFIED BY CHAMFER, INK MARK, METALLIZED MARKINGS INDENTION OR OTHER MEANS.



#### **REVISION SUMMARY**

## **Revision A (July 27, 2000)**

Initial release.

## Revision A+1 (August 4, 2000)

#### Global

Deleted references to the 48-pin reverse TSOP.

#### **Connection Diagrams**

Corrected pin 36 on TSOP package to V<sub>IO</sub>.

# Accelerated Program Operation, Unlock Bypass Command Sequence

Modified caution note regarding ACC input.

## **Revision A+2 (August 14, 2000)**

#### **Ordering Information**

Corrected 90 ns entry in V<sub>IO</sub> column for FBGA.

## Revision A+3 (August 25, 2000)

# Table 3, Am29LV065D Autoselect Codes, (High Voltage Method)

Corrected the SecSI Sector Indicator Bit codes from 80h/00h to 90h/10h.

## Revision A+4 (October 19, 2000)

#### Global

Changed data sheet status to "Preliminary."

## Revision A+5 (November 7, 2000)

### **Ordering Information**

Deleted burn-in option.

## Revision A+6 (November 27, 2000)

# Pin Description, and Table 11, Write Operation Status

Deleted references to RY/BY# being available only on the FBGA package. RY/BY# is also available on the TSOP package.

## Revision A+7 (March 8, 2001)

#### Global

Deleted "Preliminary" status from document.

# Table 4, Sector Group Protection/Unprotection Address Table

Corrected the sector group address bits for sectors 64–127.

## Revision B (January 10, 2002)

#### Global

Added TSR048 package. Clarified description of VersatileIO ( $V_{IO}$ ) in the following sections: Distinctive Characteristics; General Description; VersatileIO ( $V_{IO}$ ) Control; Operating Ranges; DC Characteristics; CMOS compatible.

Reduced typical sector erase time from 1.6 s to 0.9 s.

# Table 3, Am29LV065D Autoselect Codes, (High Voltage Method)

Corrected the autoselect code for sector protection verification.

## **Sector Group Protection and Unprotection**

Deleted reference to previous method of sector protection and unprotection.

#### **Autoselect Command Sequence**

Clarified description of function.

## SecSi (Secured Silicon) Sector Flash Memory Region

Clarified the customer lockable version of this device can be programmed and protected only once. In Table 5, changed address range in second row.

## **DC Characteristics**

Changed minimum  $V_{OH1}$  from  $0.85V_{IO}$  to  $0.8V_{IO}$ . Deleted reference to Note 6 for both  $V_{OH1}$  and  $V_{OH2}$ .

### **Erase and Program Operations table**

Corrected to indicate  $t_{\text{BUSY}}$  specification is a maximum value.

#### **Erase and Program Performance table**

Changed typical sector erase time from 1.6 s to 0.9 s and typical chip erase time from 205 s to 115 s.

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